

FEATURES

- 16 × 16 High-Speed Nonblocking Switch Array
- Serial or Parallel Programming of Switch Array
- Serial Data Out Allows "Daisy Chaining" Control of Multiple 16 × 16s to Create Larger Switch Arrays
- Output Disable Allows Connection of Multiple Devices without Loading the Output Bus
- Complete Solution
 - Buffered Inputs
 - 16 Output Amplifiers
 - Operates on ± 5 V or ± 12 V Supplies
 - Low Supply Current of 54 mA
- Excellent Audio Performance $V_S = \pm 12$ V
 - ± 10 V Output Swing
 - 0.002% THD @ 20 kHz Max. 20 V p-p ($R_L = 600 \Omega$)
- Excellent Video Performance $V_S = \pm 5$ V
 - 10 MHz 0.1 dB Gain Flatness
 - 0.1% Differential Gain Error ($R_L = 1 \text{ k}\Omega$)
 - 0.1° Differential Phase Error ($R_L = 1 \text{ k}\Omega$)
- Excellent AC Performance
 - 3 dB Bandwidth 60 MHz
- Low All Hostile Crosstalk of
 - 83 dB @ 20 kHz
- Reset Pin Allows Disabling of All Outputs (Connected to a Capacitor to Ground Provides "Power-On" Reset Capability)
- 100-Lead LQFP Package (14 mm × 14 mm)

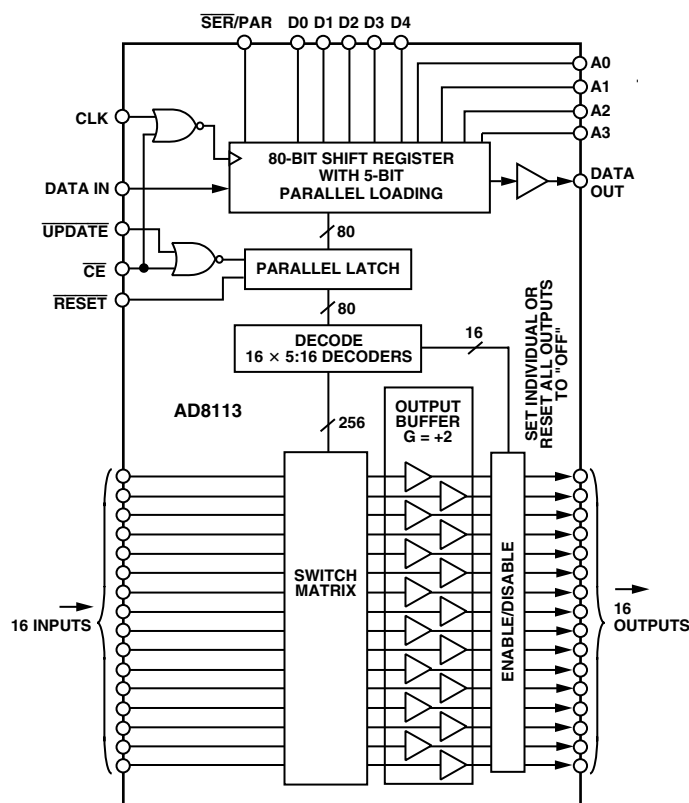
APPLICATIONS

- Analog/Digital Audio Routers
- Video Routers (NTSC, PAL, S-VIDEO, SECAM)
- Multimedia Systems
- Video Conferencing
- CCTV Surveillance

PRODUCT DESCRIPTION

The AD8113 is a fully buffered crosspoint switch matrix that operates on ± 12 V for Audio applications and ± 5 V for video applications. It offers a -3 dB signal bandwidth greater than 60 MHz and channel switch times of less than 60 ns with 0.1% settling for use in both analog and digital audio. The AD8113 operated at 20 kHz has crosstalk performance of -83 dB and isolation of 90 dB. In addition, ground/power pins surround all inputs and outputs to provide extra shielding for operation in the most demanding audio routing applications. The differential gain and differential phase of better than 0.1% and 0.1° respectively, along with 0.1 dB flatness out to 10 MHz, make the AD8113 suitable for many video applications.

FUNCTIONAL BLOCK DIAGRAM



The AD8113 includes 16 independent output buffers that can be placed into a disabled state for paralleling crosspoint outputs so that off channel loading is minimized. The AD8113 has a gain of +2. It operates on voltage supplies of ± 5 V or ± 12 V while consuming only 34 mA or 31 mA of current, respectively. The channel switching is performed via a serial digital control (which can accommodate "daisy chaining" of several devices) or via a parallel control allowing updating of an individual output without reprogramming the entire array.

The AD8113 is packaged in a 100-lead LQFP package and is available over the commercial temperature range of 0°C to 70°C.

REV. 0

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AD8113—SPECIFICATIONS ($T_A = 25^\circ\text{C}$, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$, unless otherwise noted.)

Parameter	Conditions	Min	Typ	Max	Unit
DYNAMIC PERFORMANCE					
–3 dB Bandwidth	$V_{OUT} = 200\text{ mV p-p}$, $R_L = 600\ \Omega$, $V_S = \pm 12\text{ V}$	46	60		MHz
	$V_{OUT} = 200\text{ mV p-p}$, $R_L = 150\ \Omega$, $V_S = \pm 5\text{ V}$	41	60		MHz
	$V_{OUT} = 8\text{ V p-p}$, $R_L = 600\ \Omega$, $V_S = \pm 12\text{ V}$		10		MHz
	$V_{OUT} = 2\text{ V p-p}$, $R_L = 150\ \Omega$, $V_S = \pm 5\text{ V}$		25		MHz
	0.1 dB, $V_{OUT} = 200\text{ mV p-p}$, $R_L = 150\ \Omega$, $V_S = \pm 5\text{ V}$		10		MHz
Gain Flatness	$V_{OUT} = 2\text{ V p-p}$, $R_L = 150\ \Omega$		20		ns
Propagation Delay	0.1%, 2 V Step, $R_L = 150\ \Omega$, $V_S = \pm 5\text{ V}$		23		ns
Settling Time	2 V Step, $R_L = 150\ \Omega$, $V_S = \pm 5\text{ V}$		100		V/ μs
Slew Rate	20 V Step, $R_L = 600\ \Omega$, $V_S = \pm 12\text{ V}$		120		V/ μs
NOISE/DISTORTION PERFORMANCE					
Differential Gain Error	NTSC, $R_L = 1\text{ k}\Omega$, $V_S = \pm 5\text{ V}$		0.1		%
Differential Phase Error	NTSC, $R_L = 1\text{ k}\Omega$, $V_S = \pm 5\text{ V}$		0.1		Degrees
Total Harmonic Distortion	20 kHz, $R_L = 600\ \Omega$, 20 V p-p		0.002		%
Crosstalk, All Hostile	$f = 5\text{ MHz}$, $R_L = 150\ \Omega$, $V_S = \pm 5\text{ V}$		–67		dB
	$f = 20\text{ kHz}$		–83		dB
	$f = 5\text{ MHz}$, $R_L = 150\ \Omega$, $V_S = \pm 5\text{ V}$, One Channel		–100		dB
Off Isolation	$f = 20\text{ kHz}$, One Channel		–83		dB
	20 kHz		14		nV/ $\sqrt{\text{Hz}}$
Input Voltage Noise	0.1 MHz–10 MHz		12		nV/ $\sqrt{\text{Hz}}$
DC PERFORMANCE					
Gain Error	No Load, $V_S = \pm 12\text{ V}$, $V_{OUT} = \pm 8\text{ V}$		0.3	2.5	%
	$R_L = 600\ \Omega$, $V_S = \pm 12\text{ V}$		0.5		%
	$R_L = 150\ \Omega$, $V_S = \pm 5\text{ V}$		0.5		%
Gain Matching	No Load, Channel-to-Channel		0.7	3.5	%
	$R_L = 600\ \Omega$, Channel-to-Channel		0.7		%
	$R_L = 150\ \Omega$, Channel-to-Channel		0.7		%
Gain Temperature Coefficient			20		ppm/ $^\circ\text{C}$
OUTPUT CHARACTERISTICS					
Output Resistance	Enabled		0.3		Ω
	Disabled	3.4	4		k Ω
Output Capacitance	Disabled		5		pF
Output Voltage Swing	$V_S = \pm 5\text{ V}$, No Load	± 3.2	± 3.5		V
	$V_S = \pm 12\text{ V}$, No Load	± 10.3	± 10.5		V
	$I_{OUT} = 20\text{ mA}$, $V_S = \pm 5\text{ V}$	± 2.7	± 3		V
	$I_{OUT} = 20\text{ mA}$, $V_S = \pm 12\text{ V}$	± 9.8	± 10		V
Short Circuit Current	$R_L = 0\ \Omega$		55		mA
INPUT CHARACTERISTICS					
Input Offset Voltage	All Configurations		± 4.5	± 8.5	mV
	Temperature Coefficient		10		$\mu\text{V}/^\circ\text{C}$
Input Voltage Range	No Load, $V_S = \pm 5\text{ V}$		± 1.5		V
	$V_S = \pm 12\text{ V}$		± 5.0		V
Input Capacitance	Any Switch Configuration		4		pF
Input Resistance			50		M Ω
Input Bias Current	Any Number of Enabled Inputs		1	± 1.6	μA
SWITCHING CHARACTERISTICS					
Enable On Time			80		ns
Switching Time, 2 V Step	50% Update to 1% Settling		50		ns
Switching Transient (Glitch)			20		mV p-p
POWER SUPPLIES					
Supply Current	AV_{CC} Outputs Enabled, No Load		50	54	mA
	AV_{CC} Output Disabled, $V_S = \pm 12\text{ V}$		34	38	mA
	AV_{CC} Outputs Enabled, No Load		45	50	mA
	AV_{CC} Output Disabled, $V_S = \pm 5\text{ V}$		31	35	mA
	AV_{EE} Output Enabled, No Load		50	54	mA
	AV_{EE} Output Disabled, $V_S = \pm 12\text{ V}$		34	38	mA
	AV_{EE} Output Enabled, No Load		45	50	mA
	AV_{EE} Output Disabled, $V_S = \pm 5\text{ V}$		31	35	mA
	DV_{CC} Output Enabled, No Load		8	13	mA

Parameter	Conditions	Min	Typ	Max	Unit
DYNAMIC PERFORMANCE					
Supply Voltage Range	AV_{CC}	4.5		12.6	V
	AV_{EE}	-12.6		-4.5	V
	DV_{CC}	4.5		5.5	V
PSRR	DC	75	80		dB
	$f = 100\text{ kHz}$		60		dB
	$f = 1\text{ MHz}$		40		dB
OPERATING TEMPERATURE RANGE					
Temperature Range	Operating (Still Air)		0 to 70		°C
θ_{JA}	Operating (Still Air)		40		°C/W

Specifications subject to change without notice.

TIMING CHARACTERISTICS (Serial)

Parameter	Symbol	Min	Limit Typ	Max	Unit
Serial Data Setup Time	t_1	20			ns
CLK Pulsewidth	t_2	100			ns
Serial Data Hold Time	t_3	20			ns
CLK Pulse Separation, Serial Mode	t_4	100			ns
CLK to $\overline{\text{UPDATE}}$ Delay	t_5	0			ns
$\overline{\text{UPDATE}}$ Pulsewidth	t_6	50			ns
CLK to DATA OUT Valid, Serial Mode	t_7			200	ns
Propagation Delay, $\overline{\text{UPDATE}}$ to Switch On or Off				50	ns
Data Load Time, CLK = 5 MHz, Serial Mode			16		μs
CLK, $\overline{\text{UPDATE}}$ Rise and Fall Times				100	ns
RESET Time				200	ns

Specifications subject to change without notice.

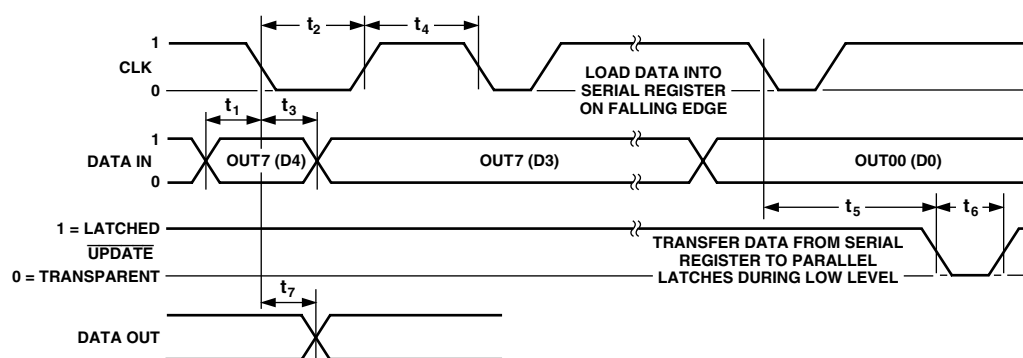


Figure 1. Timing Diagram, Serial Mode

Table I. Logic Levels

V_{IH}	V_{IL}	V_{OH}	V_{OL}	I_{IH}	I_{IL}	I_{OH}	I_{OL}
RESET, $\overline{\text{SER/PAR}}$ CLK, DATA IN, $\overline{\text{CE}}$, $\overline{\text{UPDATE}}$	RESET, $\overline{\text{SER/PAR}}$ CLK, DATA IN, $\overline{\text{CE}}$, $\overline{\text{UPDATE}}$	DATA OUT	DATA OUT	RESET, $\overline{\text{SER/PAR}}$ CLK, DATA IN, $\overline{\text{CE}}$, $\overline{\text{UPDATE}}$	RESET, $\overline{\text{SER/PAR}}$ CLK, DATA IN, $\overline{\text{CE}}$, $\overline{\text{UPDATE}}$	DATA OUT	DATA OUT
2.0 V min	0.8 V max	2.7 V min	0.5 V max	20 μA max	-400 μA min	-400 μA max	3.0 mA min

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TIMING CHARACTERISTICS (Parallel)

Parameter	Symbol	Limit		Unit
		Min	Max	
Data Setup Time	t_1	20		ns
CLK Pulsewidth	t_2	100		ns
Data Hold Time	t_3	20		ns
CLK Pulse Separation	t_4	100		ns
CLK to $\overline{\text{UPDATE}}$ Delay	t_5	0		ns
$\overline{\text{UPDATE}}$ Pulsewidth	t_6	50		ns
Propagation Delay, $\overline{\text{UPDATE}}$ to Switch On or Off			50	ns
CLK, $\overline{\text{UPDATE}}$ Rise and Fall Times			100	ns
$\overline{\text{RESET}}$ Time			200	ns

Specifications subject to change without notice.

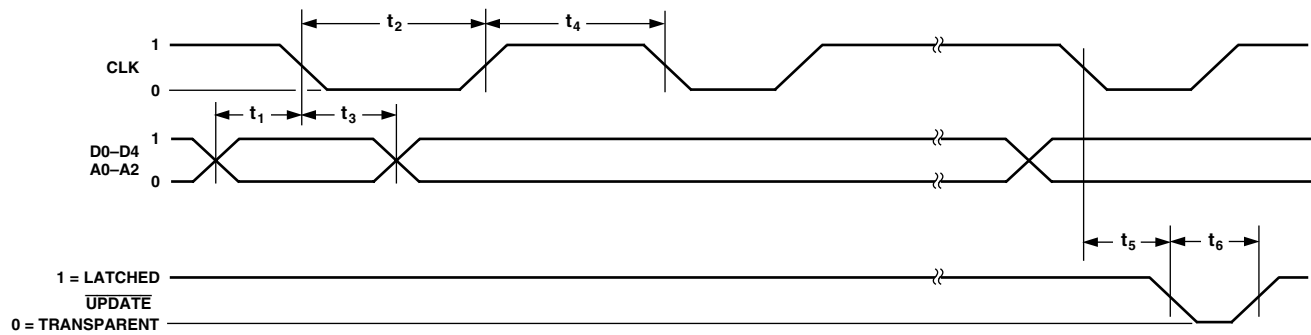


Figure 2. Timing Diagram, Parallel Mode

Table II. Logic Levels

V_{IH}	V_{IL}	V_{OH}	V_{OL}	I_{IH}	I_{IL}	I_{OH}	I_{OL}
$\overline{\text{RESET}}$, $\overline{\text{SER/PAR}}$ CLK, D0, D1, D2, D3, D4, A0, A1, A2, A3 $\overline{\text{CE}}$, $\overline{\text{UPDATE}}$	$\overline{\text{RESET}}$, $\overline{\text{SER/PAR}}$ CLK, D0, D1, D2, D3, D4, A0, A1, A2, A3 $\overline{\text{CE}}$, $\overline{\text{UPDATE}}$	DATA OUT	DATA OUT	$\overline{\text{RESET}}$, $\overline{\text{SER/PAR}}$ CLK, D0, D1, D2, D3, D4, A0, A1, A2, A3 $\overline{\text{CE}}$, $\overline{\text{UPDATE}}$	$\overline{\text{RESET}}$, $\overline{\text{SER/PAR}}$ CLK, D0, D1, D2, D3, D4, A0, A1, A2, A3 $\overline{\text{CE}}$, $\overline{\text{UPDATE}}$	DATA OUT	DATA OUT
2.0 V min	0.8 V max	2.7 V min	0.5 V max	20 μA max	-400 μA min	-400 μA max	3.0 mA min

ABSOLUTE MAXIMUM RATINGS¹

Analog Supply Voltage ($AV_{CC}-AV_{EE}$)	26.0 V
Digital Supply Voltage ($DV_{CC}-DGND$)	6 V
Ground Potential Difference (AGND–DGND)	± 0.5 V
Internal Power Dissipation ²	3.1 W
Analog Input Voltage ³	Maintain Linear Output
Digital Input Voltage	DV_{CC}
Output Voltage (Disabled Output)	
	($AV_{CC} - 1.5$ V) to ($AV_{EE} + 1.5$ V)
Output Short Circuit Duration	Momentary
Storage Temperature Range	-65°C to $+125^{\circ}\text{C}$
Lead Temperature Range (Soldering 10 sec)	300°C

NOTES

¹Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

²Specification is for device in free air ($T_A = 25^{\circ}\text{C}$):
100-lead plastic LQFP (ST): $\theta_{JA} = 40^{\circ}\text{C/W}$.

³To avoid differential input breakdown, in no case should one-half the output voltage ($1/2 V_{OUT}$) and any input voltage be greater than 10 V potential differential. See output voltage swing specification for linear output range.

POWER DISSIPATION

The AD8113 is operated with ± 5 V to ± 12 V supplies and can drive loads down to $150\ \Omega$ (± 5 V) or $600\ \Omega$ (± 12 V), resulting in a large range of possible power dissipations. For this reason, extra care must be taken derating the operating conditions based on ambient temperature.

Packaged in a 100-lead LQFP, the junction-to-ambient thermal impedance (θ_{JA}) of the AD8113 is 40°C/W . For long-term reliability, the maximum allowed junction temperature of the plastic-encapsulated die should not exceed 150°C . Temporarily exceeding this limit may cause a shift in parametric performance due to a change in the stresses exerted on the die by the package. Exceeding a junction temperature of 175°C for an extended period can result in device failure. The following curve shows the range of allowed power dissipations that meet these conditions over the commercial range of ambient temperatures.

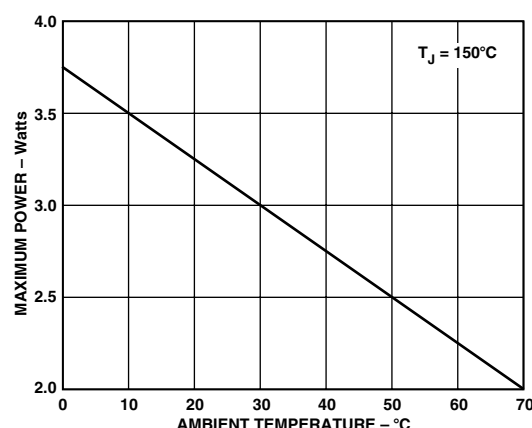


Figure 3. Maximum Power Dissipation vs. Ambient Temperature

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
AD8113JST AD8113-EVAL	0°C to 70°C	100-Lead Plastic LQFP (14 mm \times 14 mm) Evaluation Board	ST-100

CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD8113 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high-energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



Table III. Operation Truth Table

$\overline{\text{CE}}$	$\overline{\text{UPDATE}}$	CLK	DATA IN	DATA OUT	$\overline{\text{RESET}}$	$\overline{\text{SER/}}\overline{\text{PAR}}$	Operation/Comment
1	X	X	X	X	X	X	No change in logic.
0	1	$\bar{1}$	Data _i	Data _{i-80}	1	0	The data on the serial DATA IN line is loaded into serial register. The first bit clocked into the serial register appears at DATA OUT 80 clocks later.
0	1	$\bar{1}$	D0 . . . D4, A0 . . . A3	NA in Parallel Mode	1	1	The data on the parallel data lines, D0–D4, are loaded into the 80-bit serial shift register location addressed by A0–A3.
0	0	X	X	X	1	X	Data in the 80-bit shift register transfers into the parallel latches that control the switch array.
X	X	X	X	X	0	X	Latches are transparent. Asynchronous operation. All outputs are disabled. Remainder of logic is unchanged.

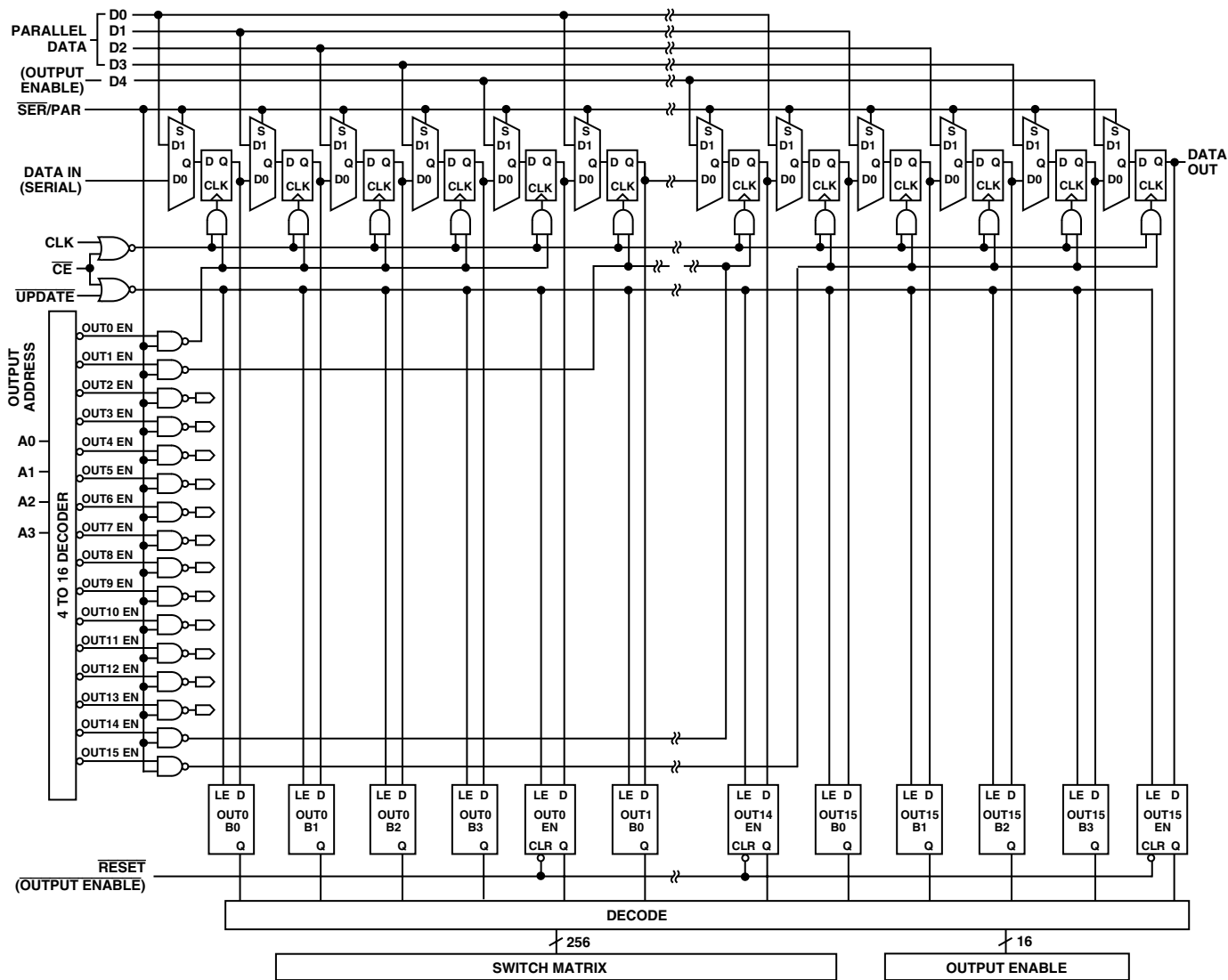


Figure 4. Logic Diagram

PIN FUNCTION DESCRIPTIONS

Pin Name	Pin Numbers	Pin Description
IN _{xx}	58, 60, 62, 64, 66, 68, 70, 72, 4, 6, 8, 10, 12, 14, 16, 18	Analog Inputs; xx = Channel Numbers 00 through 15.
DATA IN	96	Serial Data Input, TTL-Compatible.
CLK	97	Clock, TTL-Compatible. Falling Edge Triggered.
DATA OUT	98	Serial Data Out, TTL-Compatible.
UPDATE	95	Enable (Transparent) “Low.” Allows serial register to connect directly to switch matrix. Data latched when “High.”
RESET	100	Disable Outputs, Active “Low.”
CE	99	Chip Enable, Enable “Low.” <i>Must be “low” to clock in and latch data.</i>
SER/PAR	94	Selects Serial Data Mode, “Low” or Parallel Data Mode, “High.” <i>Must be connected.</i>
OUT _{yy}	53, 51, 49, 47, 45, 43, 41, 39, 37, 35, 33, 31, 29, 27, 25, 23	Analog Outputs yy = Channel Numbers 00 Through 15.
AGND	3, 5, 7, 9, 11, 13, 15, 17, 19, 57, 59, 61, 63, 65, 67, 69, 71, 73	Analog Ground for Inputs and Switch Matrix. <i>Must be connected.</i>
DV _{CC}	1, 75	5 V for Digital Circuitry.
DGND	2, 74	Ground for Digital Circuitry.
AV _{EE}	20, 56	–5 V for Inputs and Switch Matrix.
AV _{CC}	21, 55	5 V for Inputs and Switch Matrix.
AV _{CC} _{xx/yy}	54, 50, 46, 42, 38, 34, 30, 26, 22	5 V for Output Amplifier that is shared by Channel Numbers xx and yy. <i>Must be connected.</i>
AV _{EE} _{xx/yy}	52, 48, 44, 40, 36, 32, 28, 24	–5 V for Output Amplifier that is shared by Channel Numbers xx and yy. <i>Must be connected.</i>
A0	84	Parallel Data Input, TTL-Compatible (Output Select LSB).
A1	83	Parallel Data Input, TTL-Compatible (Output Select).
A2	82	Parallel Data Input, TTL-Compatible (Output Select).
A3	81	Parallel Data Input, TTL-Compatible (Output Select MSB).
D0	80	Parallel Data Input, TTL-Compatible (Input Select LSB).
D1	79	Parallel Data Input, TTL-Compatible (Input Select).
D2	78	Parallel Data Input, TTL-Compatible (Input Select).
D3	77	Parallel Data Input, TTL-Compatible (Input Select MSB).
D4	76	Parallel Data Input, TTL-Compatible (Output Enable).
NC	85–93	No Connect.

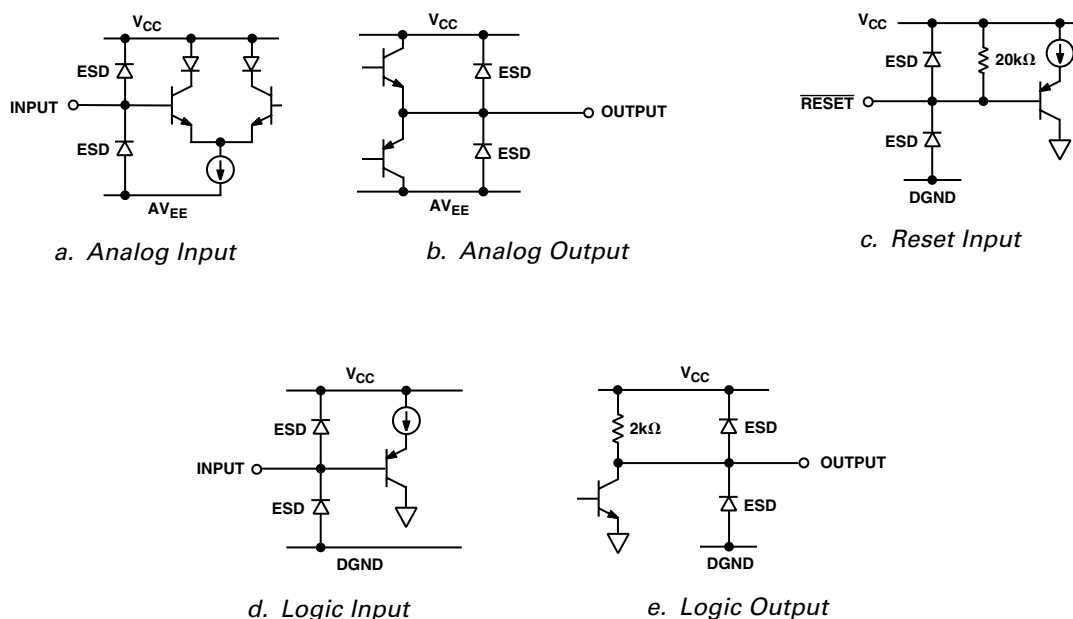
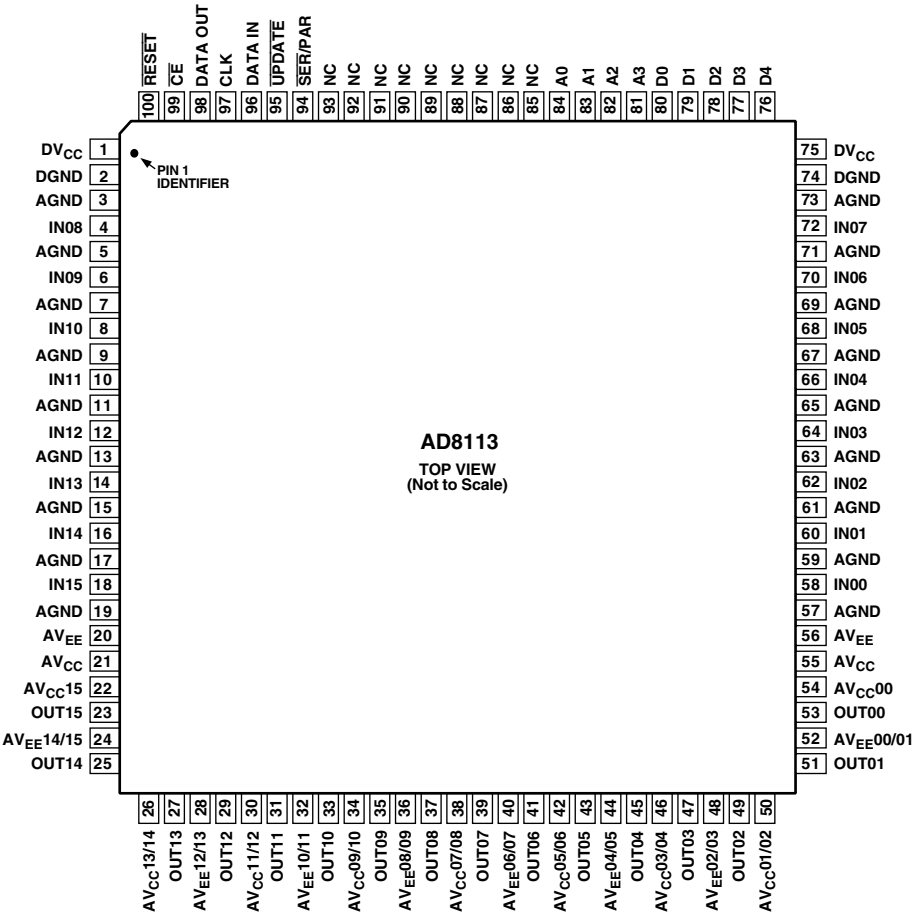


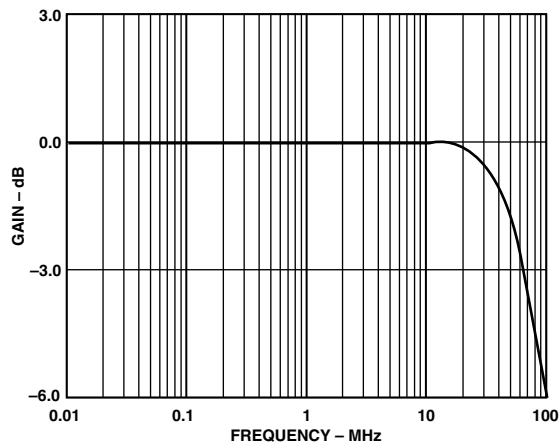
Figure 5. I/O Schematics

PIN CONFIGURATION

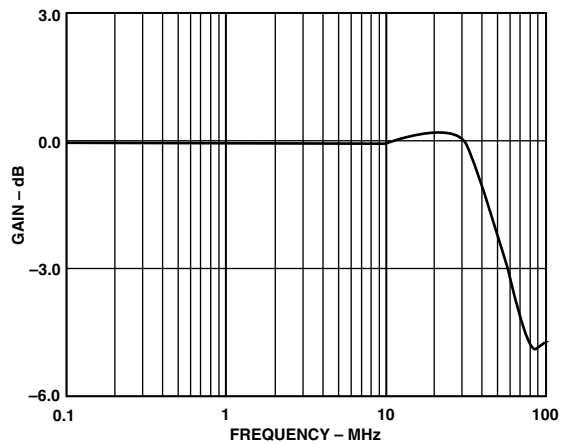


NC = NO CONNECT

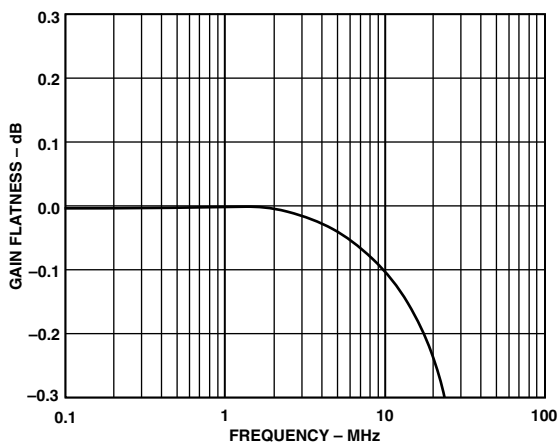
Typical Performance Characteristics–AD8113



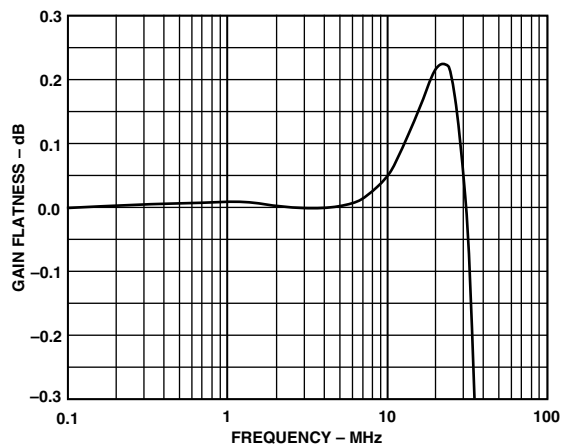
TPC 1. Small Signal Bandwidth, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$, $V_{OUT} = 200\text{ mV p-p}$



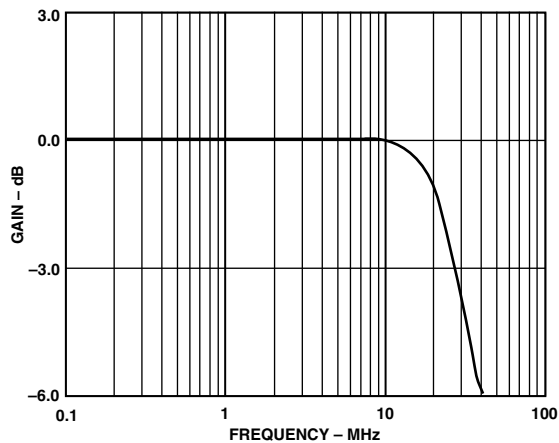
TPC 4. Small Signal Bandwidth, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$, $V_{OUT} = 200\text{ mV p-p}$



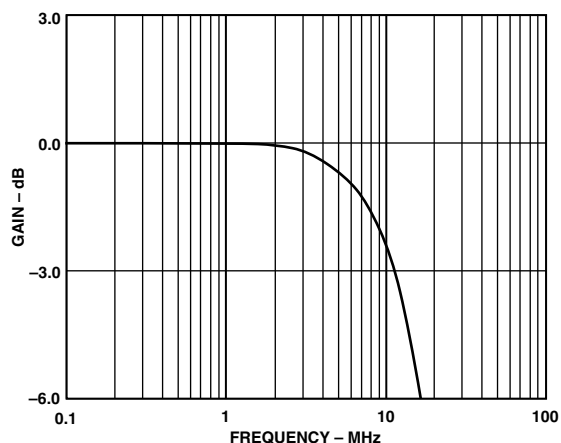
TPC 2. Small Signal Gain Flatness, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$, $V_{OUT} = 200\text{ mV p-p}$



TPC 5. Small Signal Gain Flatness, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$, $V_{OUT} = 200\text{ mV p-p}$

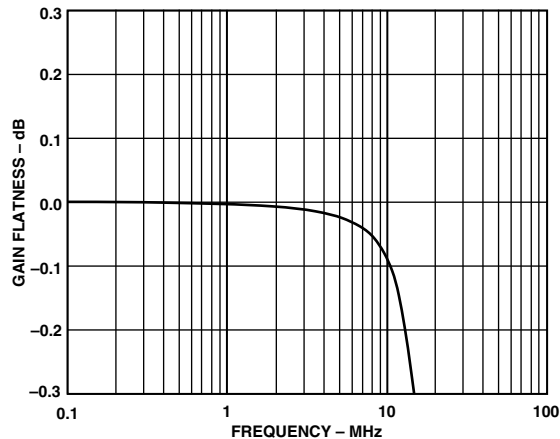


TPC 3. Large Signal Bandwidth, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$, $V_{OUT} = 2\text{ V p-p}$

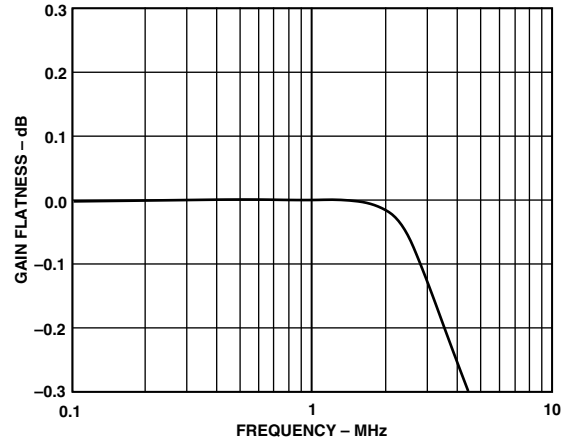


TPC 6. Large Signal Bandwidth, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$, $V_{OUT} = 8\text{ V p-p}$

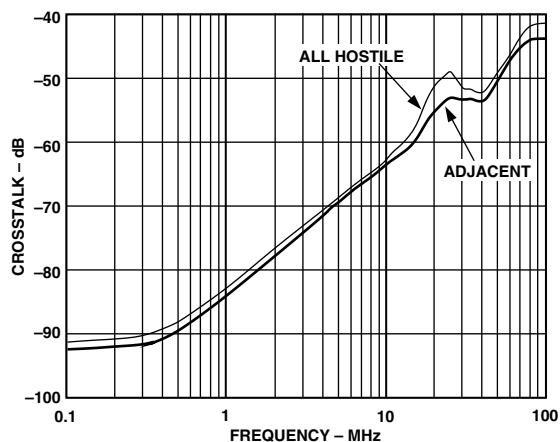
AD8113



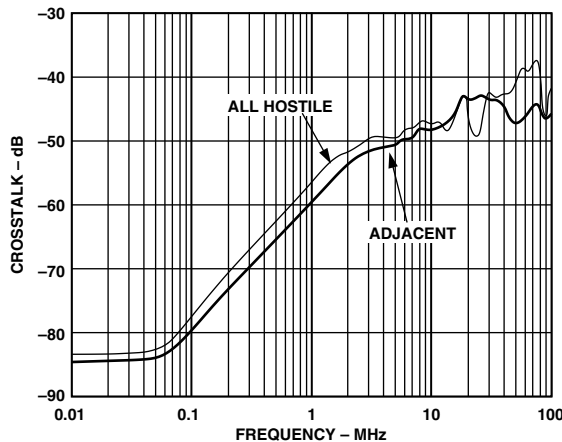
TPC 7. Large Signal Gain Flatness, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$, $V_{OUT} = 2\text{ V p-p}$



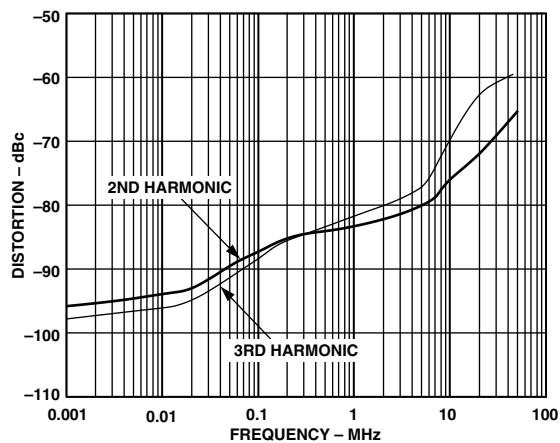
TPC 10. Large Signal Gain Flatness, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$, $V_{OUT} = 8\text{ V p-p}$



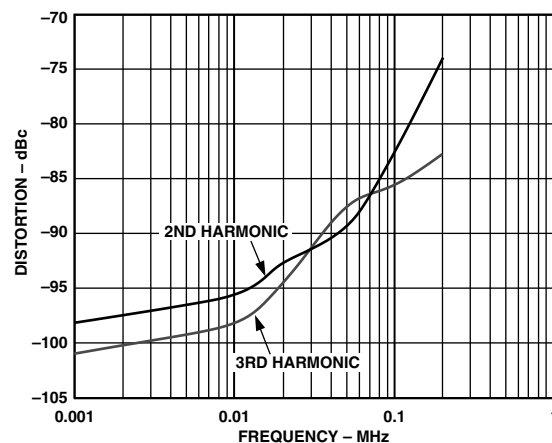
TPC 8. Crosstalk vs. Frequency, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$, $V_{OUT} = 2\text{ V p-p}$



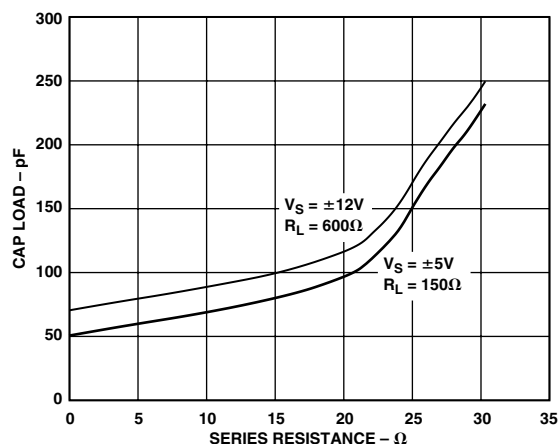
TPC 11. Crosstalk vs. Frequency, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$, $V_{OUT} = 20\text{ V p-p}$



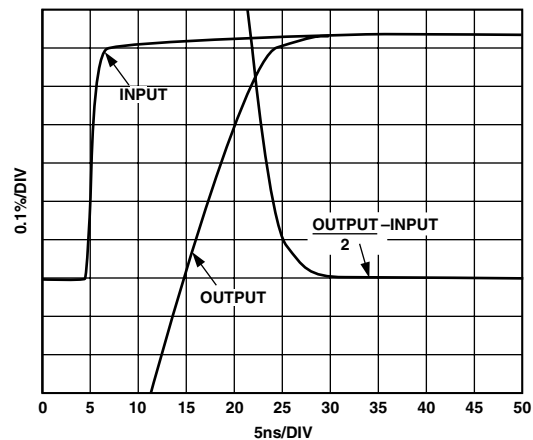
TPC 9. Distortion vs. Frequency, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$, $V_{OUT} = 2\text{ V p-p}$



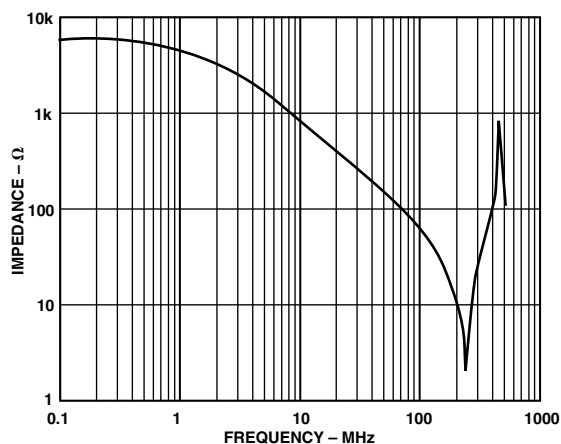
TPC 12. Distortion vs. Frequency, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$, $V_{OUT} = 20\text{ V p-p}$



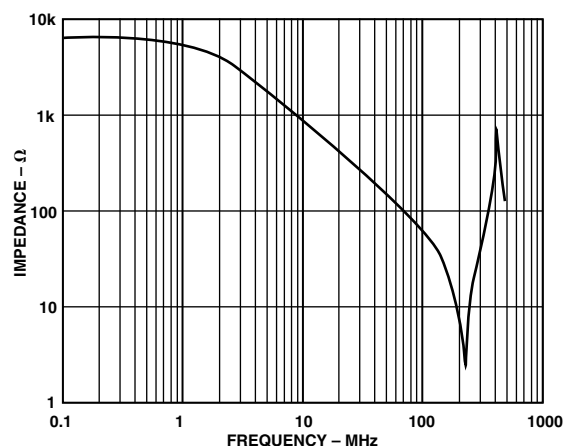
TPC 13. Cap Load vs. Series Resistance for Less than 30% Overshoot



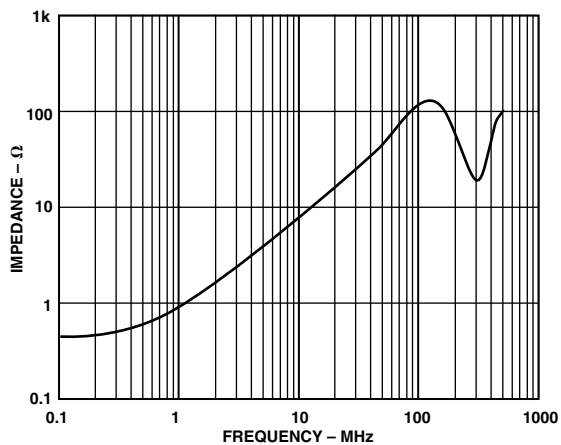
TPC 16. Settling Time to 0.1%, 2 V Step, $V_S = \pm 5$ V, $R_L = 150$ Ω



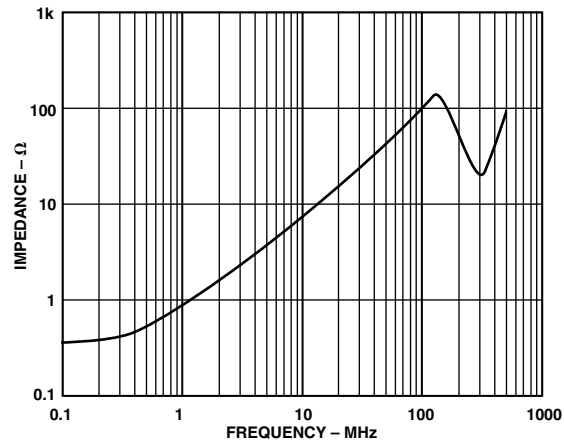
TPC 14. Disabled Output Impedance vs. Frequency, $V_S = \pm 5$ V



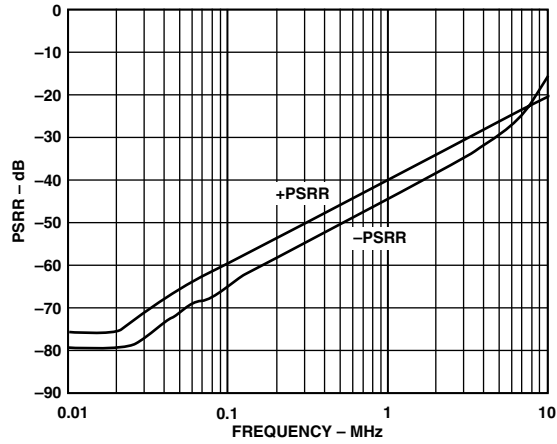
TPC 17. Disabled Output Impedance vs. Frequency, $V_S = \pm 12$ V



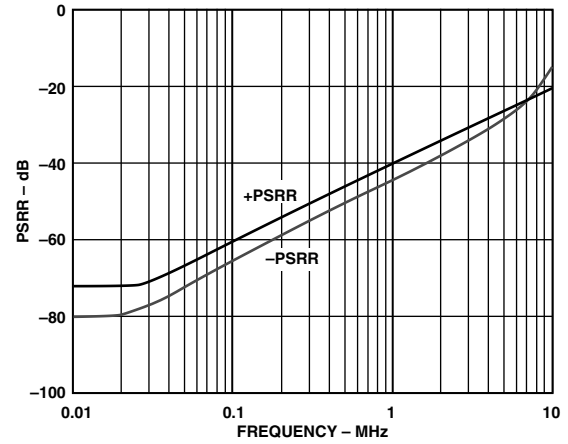
TPC 15. Enabled Output Impedance vs. Frequency, $V_S = \pm 5$ V



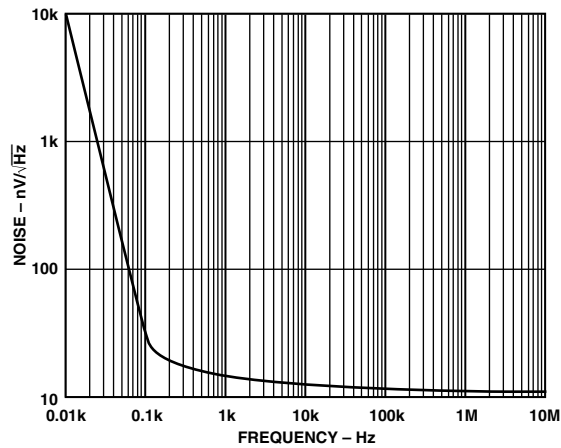
TPC 18. Enabled Output Impedance vs. Frequency, $V_S = \pm 12$ V



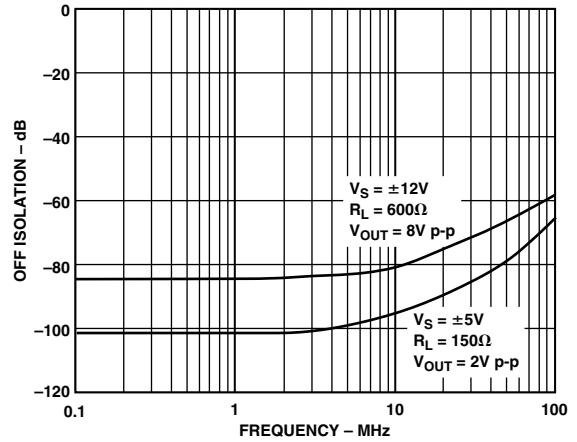
TPC 19. PSRR vs. Frequency, $V_S = \pm 5\text{ V}$



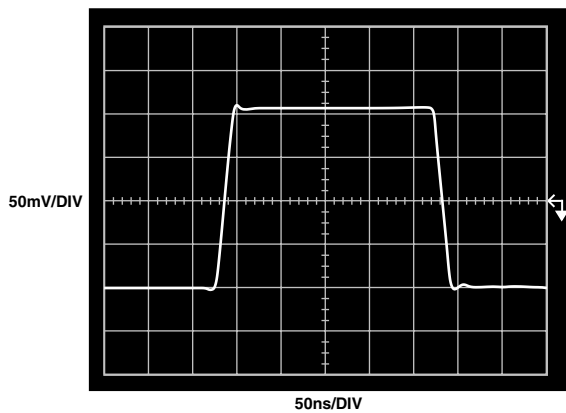
TPC 22. PSRR vs. Frequency, $V_S = \pm 12\text{ V}$



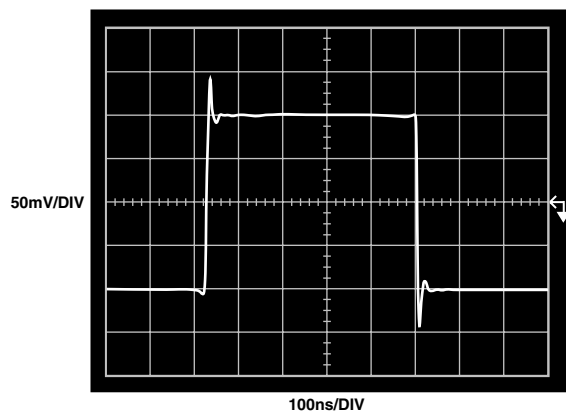
TPC 20. Noise vs. Frequency



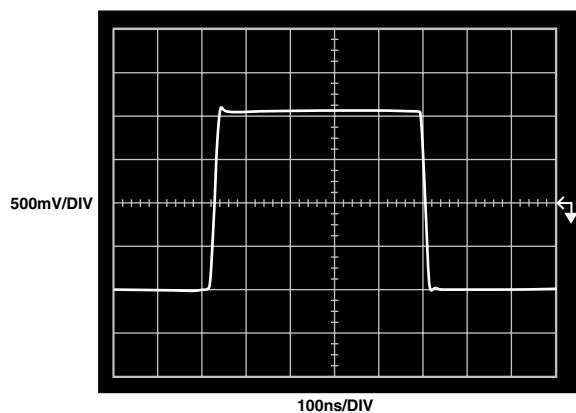
TPC 23. Off Isolation vs. Frequency



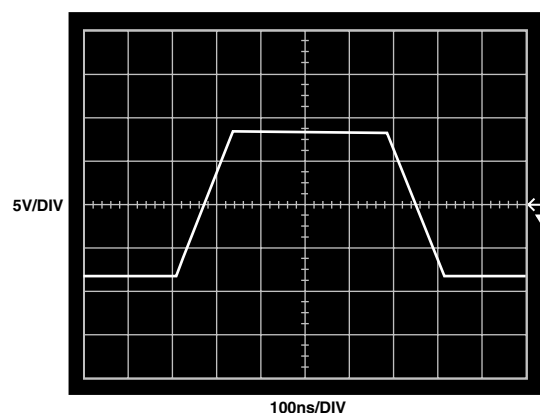
TPC 21. Small Signal Pulse Response, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$



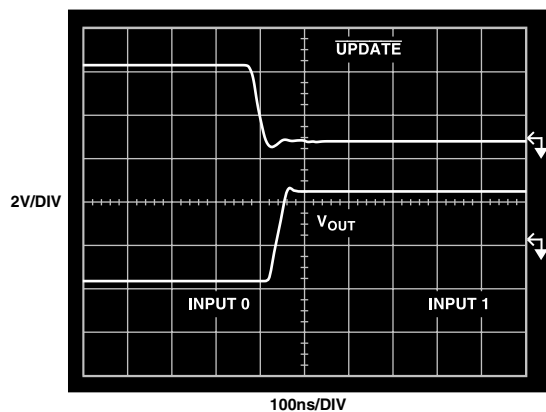
TPC 24. Small Signal Pulse Response, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$



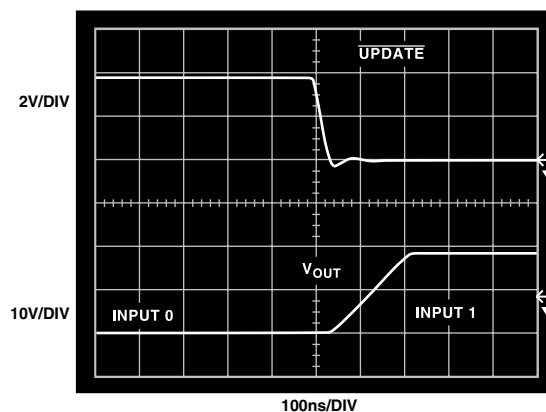
TPC 25. Large Signal Pulse Response, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$



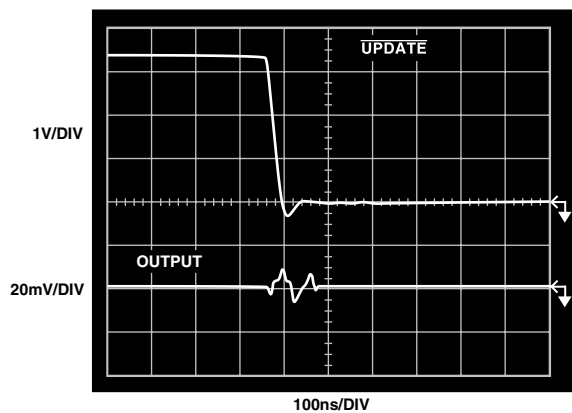
TPC 28. Large Signal Pulse Response, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$



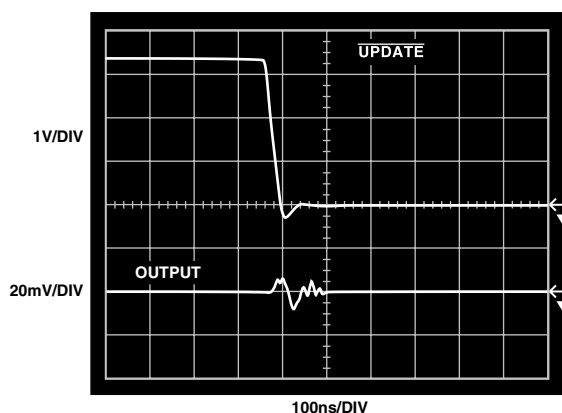
TPC 26. Switching Time, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$



TPC 29. Switching Time, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$



TPC 27. Switching Transient, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$



TPC 30. Switching Transient, $V_S = \pm 12\text{ V}$, $R_L = 600\ \Omega$

AD8113

THEORY OF OPERATION

The AD8113 is a gain-of-two crosspoint array with 16 outputs, each of which can be connected to any one of 16 inputs. Organized by output row, 16 switchable transconductance stages are connected to each output buffer in the form of a 16-to-1 multiplexer. Each of the 16 rows of transconductance stages are wired in parallel to the 16 input pins, for a total array of 256 transconductance stages. Decoding logic for each output selects one (or none) of the transconductance stages to drive the output stage. The transconductance stages are NPN-input differential pairs, sourcing current into the folded cascode output stage. The compensation networks and emitter follower output buffers are in the output stage. Voltage feedback sets the gain at +2.

When operated with ± 12 V supplies, this architecture provides ± 10 V drive for $600\ \Omega$ audio loads with extremely low distortion ($<0.002\%$) at audio frequencies. Provided the supplies are lowered to ± 5 V (to limit power consumption), the AD8113 can drive reverse-terminated video loads, swinging ± 3.0 V into $150\ \Omega$. Disabling unused outputs and transconductance stages minimizes on-chip power consumption.

Features of the AD8113 facilitate the construction of larger switch matrices. The unused outputs can be disabled, leaving only a feedback network resistance of $4\ \text{k}\Omega$ on the output. This allows multiple ICs to be bused together, provided the output load impedance is greater than minimum allowed values. Because no additional input buffering is necessary, high input resistance and low input capacitance are easily achieved without additional signal degradation.

The AD8113 inputs have a unique bias current compensation scheme that overcomes a problem common to transconductance input array architectures. Typically, input bias current increases as more and more transconductance stages connected to the same input are turned on. Anywhere from zero to sixteen transconductance stages can be sharing one input pin, so there is a varying amount of bias current supplied through the source impedance

driving the input. For audio systems with larger source impedances, this has the potential of creating large offset voltages, audible as “pops” when switching between channels. The AD8113 samples and cancels the input bias current contributions from each transconductance stage so that the residual bias current is nominally zero regardless of the number of enabled inputs.

Due to the flexibility in allowed supply voltages, internal crosstalk isolation clamps have variable bias levels. These levels were chosen to allow for the necessary input range to accommodate the full output swing with a gain of two. Overdriving the inputs beyond the device’s linear range will eventually forward-bias these clamps, increasing power dissipation. The valid input range for ± 12 V supplies is ± 5 V. The valid input range for ± 5 V supplies is ± 1.5 V. When outputs are disabled and being driven externally, the voltage applied to them should not exceed the valid output swing range for the AD8113. Exceeding ± 10.5 V on the outputs of the AD8113 may apply a large differential voltage on the unused transconductance stages and should be avoided.

A flexible TTL-compatible logic interface simplifies the programming of the matrix. Either parallel or serial loading into a first rank of latches programs each output. A global latch simultaneously updates all outputs. In serial mode, a serial-out pin allows devices to be daisy-chained together for single pin programming of multiple ICs. A power-on reset pin is available to avoid bus conflicts by disabling all outputs.

Regardless of the supply voltage applied to the AV_{CC} and AV_{EE} pins, the digital logic requires 5 V on the DV_{CC} pin with respect to DGND. In order for the digital to analog interface to work properly, DV_{CC} must be at least 7 V above AV_{EE} . Finally, internal ESD protection diodes require that the DGND and AGND pins be at the same potential.

CALCULATION OF POWER DISSIPATION

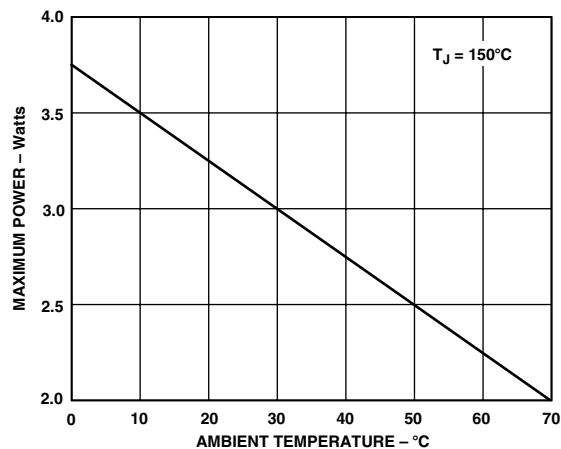


Figure 6. Maximum Power Dissipation vs. Ambient Temperature

The above curve was calculated from

$$P_{D, MAX} = \frac{(T_{JUNCTION, MAX} - T_{AMBIENT})}{\theta_{JA}}$$

As an example, if the AD8113 is enclosed in an environment at 50°C (T_A), the total on-chip dissipation under all load and supply conditions must not be allowed to exceed 2.5 W.

When calculating on-chip power dissipation, it is necessary to include the rms current being delivered to the load, multiplied by the rms voltage drop on the AD8113 output devices. The dissipation of the on-chip, 4 kΩ feedback resistor network must also be included. For a sinusoidal output, the on-chip power dissipation due to the load and feedback network can be approximated by:

$$P_{D, MAX} = (AV_{CC} - V_{OUTPUT, RMS}) \times I_{OUTPUT, RMS} + \left(\frac{V_{OUTPUT, RMS}^2}{4 \text{ k}\Omega} \right)$$

For nonsinusoidal output, the power dissipation should be calculated by integrating the on-chip voltage drop multiplied by the load current over one period.

The user may subtract the quiescent current for the Class AB output stage when calculating the loaded power dissipation. For each output stage driving a load, subtract a quiescent power according to

$$P_{D, OUTPUT} = (AV_{CC} - AV_{EE}) \times I_{O, QUIESCENT}$$

For the AD8113, $I_{O, QUIESCENT} = 0.67 \text{ mA}$.

For each disabled output, the quiescent power supply current in AV_{CC} and AV_{EE} drops by approximately 1.25 mA, although there is a power dissipation in the on-chip feedback resistors if the disabled output is being driven from an external source.

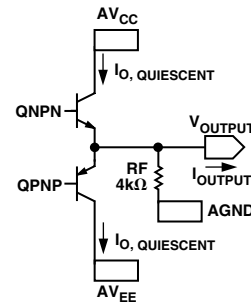


Figure 7. Simplified Output Stage

An example: AD8113, in an ambient temperature of 70°C, with all 16 outputs driving 6 V rms into 600 Ω loads. Power supplies are ±12 V.

Step 1. Calculate power dissipation of AD8113 using data sheet quiescent currents.

$$P_{D, QUIESCENT} = (AV_{CC} \times I_{AVCC}) + (AV_{EE} \times I_{AVEE}) + (DV_{CC} \times I_{DVCC})$$

$$P_{D, QUIESCENT} = (12 \text{ V} \times 54 \text{ mA}) + (-12 \text{ V} \times -54 \text{ mA}) + (5 \text{ V} \times 13 \text{ mA})$$

Step 2. Calculate power dissipation from loads.

$$P_{D, OUTPUT} = (AV_{CC} - V_{OUTPUT, RMS}) \times I_{OUTPUT, RMS} + \frac{V_{OUTPUT}^2}{4 \text{ k}\Omega}$$

$$P_{D, OUTPUT} = (12 \text{ V} - 6 \text{ V}) \times 6 \text{ V}/600 \Omega + 6 \text{ V}^2/4 \text{ k}\Omega = 69 \text{ mW}$$

There are 16 outputs, so

$$nP_{D, OUTPUT} = 16 \times 69 \text{ mW} = 1.1 \text{ W}$$

Step 3. Subtract quiescent output current for number of loads (assumes output voltage >> 0.5 V).

$$P_{DQ, OUTPUT} = (AV_{CC} - AV_{EE}) \times I_{O, QUIESCENT}$$

$$P_{DQ, OUTPUT} = (12 \text{ V} - (-12 \text{ V})) \times 0.67 \text{ mA} = 16 \text{ mW}$$

There are 16 outputs, so

$$nP_{D, OUTPUT} = 16 \times 16 \text{ mW} = 0.3 \text{ W}$$

Step 4. Verify that power dissipation does not exceed maximum allowed value.

$$P_{D, ON-CHIP} = P_{D, QUIESCENT} + nP_{D, OUTPUT} - nP_{DQ, OUTPUT}$$

$$P_{D, ON-CHIP} = 1.3 \text{ W} + 1.1 \text{ W} - 0.3 \text{ W} = 2.1 \text{ W}$$

From the figure or the equation, this power dissipation is below the maximum allowed dissipation for all ambient temperatures approaching 70°C.

NOTE: It can be shown that for a dual supply of ±a, a Class AB output stage dissipates maximum power into a grounded load when the output voltage is a/2. So for a ±12 V supply, the above example demonstrates the worst-case power dissipation into 600 Ω. It can be seen from this example that the minimum load resistance for ±12 V operation is 600 Ω (for full rated operating temperature range). For larger safety margins, when the output signal is unknown, loads of 1 kΩ and greater are recommended. When operating with ±5 V supplies, this load resistance may be lowered to 150 Ω.

AD8113

SHORT CIRCUIT OUTPUT CONDITIONS

Although there is short circuit current protection on the AD8113 outputs, the output current can reach values of 55 mA into a grounded output. Any sustained operation with even one shorted output will exceed the maximum die temperature and can result in device failure (see Absolute Maximum Ratings).

APPLICATIONS

The AD8113 has two options for changing the programming of the crosspoint matrix. In the first option a serial word of 80 bits can be provided that will update the entire matrix each time. The second option allows for changing a single output's programming via a parallel interface. The serial option requires fewer signals, but more time (clock cycles) for changing the programming, while the parallel programming technique requires more signals, but can change a single output at a time and requires fewer clock cycles to complete programming.

Serial Programming

The serial programming mode uses the device pins \overline{CE} , CLK, DATA IN, \overline{UPDATE} and $\overline{SER/PAR}$. The first step is to assert a LOW on $\overline{SER/PAR}$ in order to enable the serial programming mode. \overline{CE} for the chip must be LOW to allow data to be clocked into the device. The \overline{CE} signal can be used to address an individual device when devices are connected in parallel.

The \overline{UPDATE} signal should be HIGH during the time that data is shifted into the device's serial port. Although the data will still shift in when \overline{UPDATE} is LOW, the transparent, asynchronous latches will allow the shifting data to reach the matrix. This will cause the matrix to try to update to every intermediate state as defined by the shifting data.

The data at DATA IN is clocked in at every down edge of CLK. A total of 80 bits must be shifted in to complete the programming. For each of the 16 outputs, there are four bits (D0–D3) that determine the source of its input followed by one bit (D4) that determines the enabled state of the output. If D4 is LOW (output disabled), the four associated bits (D0–D3) do not matter, because no input will be switched to that output.

The most-significant-output-address data is shifted in first, then following in sequence until the least-significant-output-address data is shifted in. At this point \overline{UPDATE} can be taken LOW, which will cause the programming of the device according to the data that was just shifted in. The \overline{UPDATE} registers are asynchronous and when \overline{UPDATE} is LOW (and \overline{CE} is LOW), they are transparent.

If more than one AD8113 device is to be serially programmed in a system, the DATA OUT signal from one device can be connected to the DATA IN of the next device to form a serial chain. All of the CLK, \overline{CE} , \overline{UPDATE} and $\overline{SER/PAR}$ pins should be connected in parallel and operated as described above. The serial data is input to the DATA IN pin of the first device of the chain, and it will ripple through to the last. Therefore, the data for the last device in the chain should come at the beginning of the programming sequence. The length of the programming sequence will be 80 bits times the number of devices in the chain.

Parallel Programming

When using the parallel programming mode, it is not necessary to reprogram the entire device when making changes to the matrix. In fact, parallel programming allows the modification of a single output at a time. Since this takes only one CLK/

\overline{UPDATE} cycle, significant time savings can be realized by using parallel programming.

One important consideration in using parallel programming is that the \overline{RESET} signal DOES NOT RESET ALL REGISTERS in the AD8113. When taken LOW, the \overline{RESET} signal will only set each output to the disabled state. This is helpful during power-up to ensure that two parallel outputs will not be active at the same time.

After initial power-up, the internal registers in the device will generally have random data, even though the \overline{RESET} signal has been asserted. If parallel programming is used to program one output, then that output will be properly programmed, but the rest of the device will have a random program state depending on the internal register content at power-up. Therefore, when using parallel programming, it is essential that ALL OUTPUTS BE PROGRAMMED TO A DESIRED STATE AFTER POWER-UP. This will ensure that the programming matrix is always in a known state. From then on, parallel programming can be used to modify a single output or more at a time.

In similar fashion, if both \overline{CE} and \overline{UPDATE} are taken LOW after initial power-up, the random power-up data in the shift register will be programmed into the matrix. Therefore, in order to prevent the crosspoint from being programmed into an unknown state, DO NOT APPLY LOW LOGIC LEVELS TO BOTH \overline{CE} AND \overline{UPDATE} AFTER POWER IS INITIALLY APPLIED. Programming the full shift register one time to a desired state, by either serial or parallel programming after initial power-up, will eliminate the possibility of programming the matrix to an unknown state.

To change an output's programming via parallel programming, $\overline{SER/PAR}$ and \overline{UPDATE} should be taken HIGH and \overline{CE} should be taken LOW. The CLK signal should be in the HIGH state. The 4-bit address of the output to be programmed should be put on A0–A3. The first four data bits (D0–D3) should contain the information that identifies the input that gets programmed to the output that is addressed. The fifth data bit (D4) will determine the enabled state of the output. If D4 is LOW (output disabled), then the data on D0–D3 does not matter.

After the desired address and data signals have been established, they can be latched into the shift register by a HIGH to LOW transition of the CLK signal. The matrix will not be programmed, however, until the \overline{UPDATE} signal is taken low. It is thus possible to latch in new data for several or all of the outputs first via successive negative transitions of CLK while \overline{UPDATE} is held high, and then have all the new data take effect when \overline{UPDATE} goes LOW. This is the technique that should be used when programming the device for the first time after power-up when using parallel programming.

POWER-ON RESET

When powering up the AD8113, it is usually desirable to have the outputs come up in the disabled state. The \overline{RESET} pin, when taken LOW, will cause all outputs to be in the disabled state. However, the \overline{RESET} signal DOES NOT RESET ALL REGISTERS in the AD8113. This is important when operating in the parallel programming mode. Please refer to that section for information about programming internal registers after power-up. Serial programming will program the entire matrix each time, so no special considerations apply.

Since the data in the shift register is random after power-up, it should not be used to program the matrix, or else the matrix can enter unknown states. To prevent this, **DO NOT APPLY LOGIC LOW SIGNALS TO BOTH \overline{CE} AND \overline{UPDATE} INITIALLY AFTER POWER-UP.** The shift register should first be loaded with the desired data, and then \overline{UPDATE} can be taken LOW to program the device.

The \overline{RESET} pin has a 20 k Ω pull-up resistor to DVDD that can be used to create a simple power-up reset circuit. A capacitor from \overline{RESET} to ground will hold \overline{RESET} LOW for some time while the rest of the device stabilizes. The LOW condition will cause all the outputs to be disabled. The capacitor will then charge through the pull-up resistor to the HIGH state, thus allowing full programming capability of the device.

SPECIFYING AUDIO LEVELS

Several methods are used to specify audio levels. A level is actually a power measurement, which requires not just a voltage measurement, but also a reference impedance. Traditionally both 150 Ω and 600 Ω have been used as references for audio level measurements.

The typical reference power level is one milliwatt. Power levels that are measured relative to this reference level are given the designation dBm. However, it is always necessary to be sure of the reference impedance used for such measurements. This can be either explicit, e.g., 0 dBm (600 Ω) or implicit, if there is certain agreement on what the reference impedance is.

Since modern voltmeters have high input impedances, measurements can be made that do not terminate the signal. Therefore, it is not proper to consider this type of measurement a dBm, or power measurement. However, a measurement scale that is designated dBu is now used to measure unterminated voltages. This scale has a voltage reference for 0 dBu that is the same as the voltage required to produce 0 dBm (600 Ω).

Since $P = V^2/R$, the voltage required to create 1 mW into 600 Ω is 0.775 V rms. This is the voltage reference (0 dB) used for dBu measurements without regard to the impedance.

The AD8113 operates as a voltage-in, voltage-out device. Therefore, it is easiest to specify all of its parameters in volts, and leave it to the user to convert these to other power units or dB-type measurements as required by the particular application.

CREATING UNITY-GAIN CHANNELS

The channels in the AD8113 have a gain of two. This gain is necessary as opposed to a gain of unity in order to restrict the voltage on internal nodes to less than the breakdown voltage. If it is desired to create channels with an overall gain of unity, then a resistive divider at the input will divide the signals by two. After passing through any input/output channel combination of the AD8113, the overall gain will be unity.

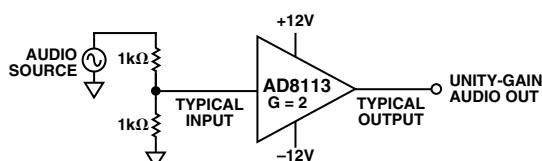


Figure 8. Input Divide Circuit

Figure 8 shows a typical input with a divide-by-two input divider that will create a unity gain channel. The circuit uses 1 k Ω resistors to form the divider. These resistors need to be high enough so they will not overload the drive circuit. But if they are too high, they will generate an offset voltage due to the input bias current that flows through them. Larger resistors will also increase the thermal noise of the channel.

This circuit can handle inputs that swing up to ± 10 V when the AD8113 operates on analog supplies of ± 12 V. After the divider, the maximum voltage will be ± 5 V at the input. This maximum input amplitude will be ± 10 V at the output after the gain-of-two of the channel.

VIDEO SIGNALS

Unlike audio signals, which have lower bandwidths and longer wavelengths, video signals often use controlled-impedance transmission lines that are terminated in their characteristic impedance. While this is not always the case, there are some considerations when using the AD8113 to route video signals with controlled-impedance transmission lines. Figure 9 shows a schematic of an input and output treatment of a typical video channel.

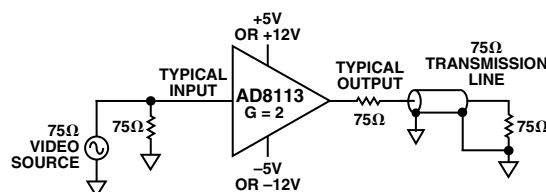


Figure 9. Video Signal Circuit

Video signals usually use 75 Ω transmission lines that need to be terminated with this value of resistance at each end. When such a source is delivered to one of the AD8113 inputs, the high input impedance will not properly terminate these signals. Therefore, the line should be terminated with a 75 Ω shunt resistor to ground. Since video signals are limited in their peak-to-peak amplitude, there is no need to attenuate video signals before they pass through the AD8113.

The AD8113 outputs are very low impedance and will not properly terminate the source end of a 75 Ω transmission line. In these cases, a series 75 Ω resistor should be inserted at an output that will drive a video signal. Then the transmission line should be terminated with 75 Ω at its far end. This overall termination scheme will divide the amplitude of the AD8113 output by two. An overall unity-gain channel is produced as a result of the channel gain-of-two of the AD8113.

Power Considerations of Video Signals

If the AD8113 is used only to route conventional video signals, then it is recommended to run on analog supplies of ± 5 V. This is all that is necessary for video signals, because they are limited in their amplitude to generally less than 2 V p-p at the output, after the channel gain-of-two. There will be significant power savings when routing video signals with lower supply voltages.

If an AD8113 is used to route a mix of audio and video signals, then other factors must be considered. In general, the analog supplies will be at ± 12 V to handle the high signal levels required for the audio.

AD8113

Inputs and outputs should be preassigned to be either audio or video. As described above, audio and video signals are treated differently, so it is difficult to have the same AD8113 inputs or outputs route audio or video signals in the same system at different times. The various audio and video channels should be configured as described in the above sections.

Video outputs that drive a terminated 75 Ω transmission line (150 Ω equivalent load) will dissipate significantly more power with ± 12 V supplies. An upper bound on power dissipation can be approximated by the following method.

A video signal at the AD8113 output can have a maximum value of 2 V. This is quite conservative, because most video signals are about 700 mV peak at unity gain or 1.4 V peak after a gain-of-two. A video signal only reaches this level when the video content is at peak white, so this value is even more pessimistic.

Finally, a video signal will generally have some kind of sync and blanking interval where its amplitude will be either 0 V (or black) or very close to this level. The power dissipation will be much lower during this period and this will occur at a very regular duty cycle.

If the full 2 V signal is assumed to be present at 100% duty cycle at the output, then the current in the output is $2 \text{ V}/150 \Omega = 13.3 \text{ mA}$. If the positive supply is at 12 V, there will be a 10 V drop in the AD8113 output stage from the supply to the output. This yields a power dissipated in the output of 133 mW from one video load when running on supplies of ± 12 V. This is by far a worst-case situation, and this power dissipation factor can be adjusted lower by adjusting for actual video levels, sync-interval duty cycle and average picture level considerations.

If too much power will be dissipated in this type of configuration, it is possible to lower it by buffering the output. An AD8113 video output drives a divide-by-two resistive divider that is made up of two 1 k Ω resistors. This presents a total load of 2 k Ω to the AD8113 outputs, which significantly reduces the power dissipation. Refer to Figure 10.

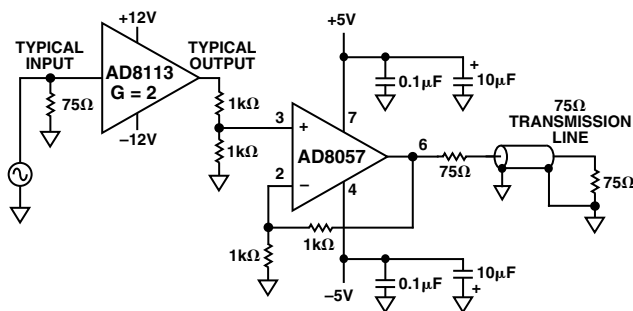


Figure 10. Video Buffer Circuit

After this divider, the signal is now at a unity level, because of the channel gain of the AD8113 and the attenuation of the divider. An AD8057 is configured as a gain-of-two buffer to drive the terminated transmission line. The AD8058 is a dual version of the AD8057.

The maximum supply voltage of the AD8057 is only about ± 6 V. If the only system supplies that are available are ± 12 V, a higher voltage video op amp can be substituted for the AD8057. Good candidates are the AD817 and AD818 or, if dual op amps are desired, the AD826 and AD828.

CREATING LARGER CROSSPOINT ARRAYS

The AD8113 is a high density building block for creating crosspoint arrays of dimensions larger than 16×16 . Various features, such as output disable and chip enable, are useful for creating larger arrays.

The first consideration in constructing a larger crosspoint is to determine the minimum number of devices required. The 16×16 architecture of the AD8113 contains 256 “points,” which is a factor of 64 greater than a 4×1 crosspoint (or multiplexer). The PC board area, power consumption, and design effort savings are readily apparent when compared to using these smaller devices.

For a nonblocking crosspoint, the number of points required is the product of the number of inputs multiplied by the number of outputs. Nonblocking requires that the programming of a given input to one or more outputs does not restrict the availability of that input to be a source for any other outputs.

Some nonblocking crosspoint architectures will require more than this minimum as calculated above. Also, there are blocking architectures that can be constructed with fewer devices than this minimum. These systems have connectivity available on a statistical basis that is determined when designing the overall system.

The basic concept in constructing larger crosspoint arrays is to connect inputs in parallel in a horizontal direction and to “wire-OR” the outputs together in the vertical direction. The meaning of horizontal and vertical can best be understood by looking at a diagram. Figure 11 illustrates this concept for a 32×32 crosspoint array that uses four AD8113s.

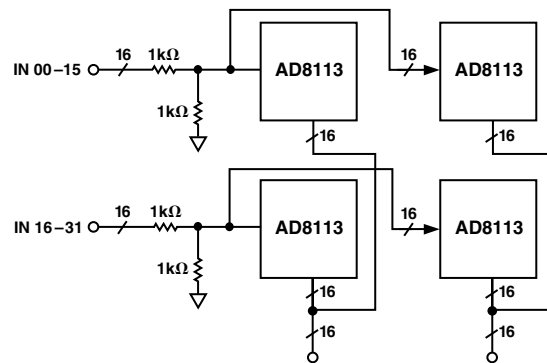


Figure 11. 32×32 Audio Crosspoint Array Using Four AD8113s

The inputs are individually assigned to each of the 32 inputs of the two devices and a divider is used to normalize the channel gain. The outputs are wire-ORed together in pairs. The output from only one of a wire-ORed pair should be enabled at any given time. The device programming software must be properly written to cause this to happen.

Using additional crosspoint devices in the design can lower the number of outputs that have to be wire-ORed together. Figure 12 shows a block diagram of a system using ten AD8113s to create a nonblocking, gain-of-two, 128×16 crosspoint that restricts the wire-ORing at the output to only four outputs.

Additionally, by using the lower eight outputs from each of the two Rank 2 AD8113s, a blocking 128×32 crosspoint array can be realized. There are, however, some drawbacks to this technique. The offset voltages of the various cascaded devices will

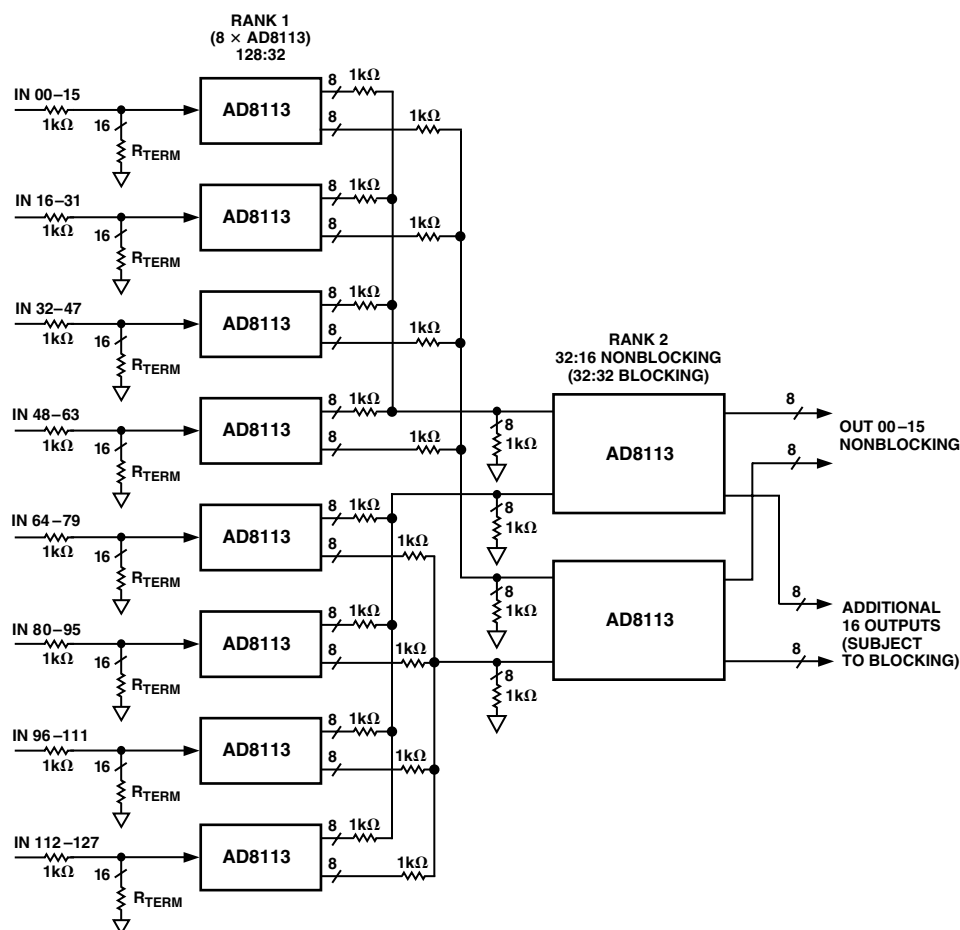


Figure 12. Nonblocking 128×16 Audio Array (128×32 Blocking)

accumulate, and the bandwidth limitations of the devices will compound. In addition, the extra devices will consume more current and take up more board space. Once again, the overall system design specifications will determine how to make the various trade-offs.

Multichannel Video and Audio

The good video specifications of the AD8113 make it an ideal candidate for creating composite video crosspoint switches. These can be made quite dense by taking advantage of the AD8113's high level of integration and the fact that composite video requires only one crosspoint channel per system video channel. There are, however, other video formats that can be routed with the AD8113 requiring more than one crosspoint channel per video channel.

Some systems use twisted-pair wiring to carry video or audio signals. These systems utilize differential signals and can lower costs because they use lower cost cables, connectors and termination methods. They also have the ability to lower crosstalk and reject common-mode signals, which can be important for equipment that operates in noisy environments or where common-mode voltages are present between transmitting and receiving equipment.

In such systems, the audio or video signals are differential; there is a positive and negative (or inverted) version of the signals. These complementary signals are transmitted onto each of the two wires of the twisted pair, yielding a first order zero common-mode voltage. At the receive end, the signals are differentially received and converted back into a single-ended signal.

When switching these differential signals, two channels are required in the switching element to handle the two differential signals that make up the video or audio channel. Thus, one differential video or audio channel is assigned to a pair of crosspoint channels, both input and output. For a single AD8113, eight differential video or audio channels can be assigned to the 16 inputs and 16 outputs. This will effectively form an 8×8 differential crosspoint switch.

Programming such a device will require that inputs and outputs be programmed in pairs. This information can be deduced by inspection of the programming format of the AD8113 and the requirements of the system.

There are other analog video formats requiring more than one analog circuit per video channel. One two-circuit format that is commonly being used in systems such as satellite TV, digital cable boxes and higher quality VCRs, is called S-video or Y/C video. This format carries the brightness (luminance or Y) portion of the video signal on one channel and the color (chrominance, chroma or C) on a second channel.

Since S-video also uses two separate circuits for one video channel, creating a crosspoint system requires assigning one video channel to two crosspoint channels as in the case of a differential video system. Aside from the nature of the video format, other aspects of these two systems will be the same. Stereo audio can also be routed in a paired-channel arrangement similar to a two-channel video system.

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There are yet other video formats using three channels to carry the video information. Video cameras produce RGB (red, green, blue) directly from the image sensors. RGB is also the usual format used by computers internally for graphics. RGB can also be converted to Y, R-Y, B-Y format, sometimes called YUV format. These three-circuit video standards are referred to as component analog video.

The component video standards require three crosspoint channels per video channel to handle the switching function. In a fashion similar to the two-circuit video formats, the inputs and outputs are assigned in groups of three and the appropriate logic programming is performed to route the video signals.

CROSSTALK

Many systems, such as studio audio or broadcast video, that handle numerous analog signal channels, have strict requirements for keeping the various signals from influencing any of the others in the system. Crosstalk is the term used to describe the coupling of the signals of other nearby channels to a given channel.

When there are many signals in close proximity in a system, as will undoubtedly be the case in a system that uses the AD8113, the crosstalk issues can be quite complex. A good understanding of the nature of crosstalk and some definition of terms is required in order to specify a system that uses one or more AD8113s.

Types of Crosstalk

Crosstalk can be propagated by means of any of three methods. These fall into the categories of electric field, magnetic field, and sharing of common impedances. This section will explain these effects.

Every conductor can be both a radiator of electric fields and a receiver of electric fields. The electric field crosstalk mechanism occurs when the electric field created by the transmitter propagates across a stray capacitance (e.g., free space) and couples with the receiver and induces a voltage. This voltage is an unwanted crosstalk signal in any channel that receives it.

Currents flowing in conductors create magnetic fields that circulate around the currents. These magnetic fields will then generate voltages in any other conductors whose paths they link. The undesired induced voltages in these other channels are crosstalk signals. The channels that crosstalk can be said to have a mutual inductance that couples signals from one channel to another.

The power supplies, grounds, and other signal return paths of a multichannel system are generally shared by the various channels. When a current from one channel flows in one of these paths, a voltage that is developed across the impedance becomes an input crosstalk signal for other channels that share the common impedance.

All these sources of crosstalk are vector quantities, so the magnitudes cannot simply be added together to obtain the total crosstalk. In fact, there are conditions where driving additional circuits in parallel in a given configuration can actually reduce the crosstalk.

Areas of Crosstalk

For a practical AD8113 circuit, it is required that it be mounted to some sort of circuit board in order to connect it to power supplies and measurement equipment. Great care has been taken to create a characterization board (also available as an evaluation board) that adds minimum crosstalk to the intrinsic device. This,

however, raises the issue that a system's crosstalk is a combination of the intrinsic crosstalk of the devices in addition to the circuit board to which they are mounted. It is important to try to separate these two areas of crosstalk when attempting to minimize its effect.

In addition, crosstalk can occur among the inputs to a crosspoint and among the output. It can also occur from input to output. Techniques will be discussed for diagnosing which part of a system is contributing to crosstalk.

Measuring Crosstalk

Crosstalk is measured by applying a signal to one or more channels and measuring the relative strength of that signal on a desired selected channel. The measurement is usually expressed as dB down from the magnitude of the test signal. The crosstalk is expressed by:

$$|XT| = 20 \log_{10} (A_{sel}(s)/A_{test}(s))$$

where $s = j\omega$ is the Laplace transform variable, $A_{sel}(s)$ is the amplitude of the crosstalk-induced signal in the selected channel and $A_{test}(s)$ is the amplitude of the test signal. It can be seen that crosstalk is a function of frequency, but not a function of the magnitude of the test signal (to first order). In addition, the crosstalk signal will have a phase relative to the test signal associated with it.

A network analyzer is most commonly used to measure crosstalk over a frequency range of interest. It can provide both magnitude and phase information about the crosstalk signal.

As a crosspoint system or device grows larger, the number of theoretical crosstalk combinations and permutations can become extremely large. For example, in the case of the 16×16 matrix of the AD8113, we can examine the number of crosstalk terms that can be considered for a single channel, say IN00 input. IN00 is programmed to connect to one of the AD8113 outputs where the measurement can be made.

First, we can measure the crosstalk terms associated with driving a test signal into each of the other 15 inputs one at a time, while applying no signal to IN00. We can then measure the crosstalk terms associated with driving a parallel test signal into all 15 other inputs taken two at a time in all possible combinations; and then three at a time, etc., until, finally, there is only one way to drive a test signal into all 15 other inputs in parallel.

Each of these cases is legitimately different from the others and might yield a unique value, depending on the resolution of the measurement system, but it is hardly practical to measure all these terms and then to specify them. In addition, this describes the crosstalk matrix for just one input channel. A similar crosstalk matrix can be proposed for every other input. In addition, if the possible combinations and permutations for connecting inputs to the other (not used for measurement) outputs are taken into consideration, the numbers rather quickly grow to astronomical proportions. If a larger crosspoint array of multiple AD8113s is constructed, the numbers grow larger still.

Obviously, some subset of all these cases must be selected to be used as a guide for a practical measure of crosstalk. One common method is to measure "all hostile" crosstalk. This term means that the crosstalk to the selected channel is measured while all other system channels are driven in parallel. In general, this will yield the worst crosstalk number, but this is not always the case, due to the vector nature of the crosstalk signal.

Other useful crosstalk measurements are those created by one nearest neighbor or by the two nearest neighbors on either side. These crosstalk measurements will generally be higher than those of more distant channels, so they can serve as a worst-case measure for any other one-channel or two-channel crosstalk measurements.

Input and Output Crosstalk

The flexible programming capability of the AD8113 can be used to diagnose whether crosstalk is occurring more on the input side or the output side. Some examples are illustrative. A given input channel (IN07 in the middle for this example) can be programmed to drive OUT07 (also in the middle). The input to IN07 is just terminated to ground (via 50 Ω or 75 Ω) and no signal is applied.

All the other inputs are driven in parallel with the same test signal (practically provided by a distribution amplifier), with all other outputs except OUT07 disabled. Since grounded IN07 is programmed to drive OUT07, no signal should be present. Any signal that is present can be attributed to the other 15 hostile input signals, because no other outputs are driven (they are all disabled). Thus, this method measures the all-hostile input contribution to crosstalk into IN07. Of course, the method can be used for other input channels and combinations of hostile inputs.

For output crosstalk measurement, a single input channel is driven (IN00 for example) and all outputs other than a given output (IN07 in the middle) are programmed to connect to IN00. OUT07 is programmed to connect to IN15 (far away from IN00), which is terminated to ground. Thus OUT07 should not have a signal present since it is listening to a quiet input. Any signal measured at the OUT07 can be attributed to the output crosstalk of the other 16 hostile outputs. Again, this method can be modified to measure other channels and other crosspoint matrix combinations.

Effect of Impedances on Crosstalk

The input side crosstalk can be influenced by the output impedance of the sources that drive the inputs. The lower the impedance of the drive source, the lower the magnitude of the crosstalk. The dominant crosstalk mechanism on the input side is capacitive coupling. The high impedance inputs do not have significant current flow to create magnetically induced crosstalk. However, significant current can flow through the input termination resistors and the loops that drive them. Thus, the PC board on the input side can contribute to magnetically coupled crosstalk.

From a circuit standpoint, the input crosstalk mechanism looks like a capacitor coupling to a resistive load. For low frequencies the magnitude of the crosstalk will be given by:

$$|XT| = 20 \log_{10} [(R_S C_M) \times s]$$

where R_S is the source resistance, C_M is the mutual capacitance between the test signal circuit and the selected circuit, and s is the Laplace transform variable.

From the equation it can be observed that this crosstalk mechanism has a high-pass nature; it can also be minimized by reducing the coupling capacitance of the input circuits and lowering the output impedance of the drivers. If the input is driven from a 75 Ω terminated cable, the input crosstalk can be reduced by buffering this signal with a low output impedance buffer.

On the output side, the crosstalk can be reduced by driving a lighter load. Although the AD8113 is specified with excellent differential gain and phase when driving a standard 150 Ω video load, the crosstalk will be higher than the minimum obtainable due to the high output currents. These currents will induce crosstalk via the mutual inductance of the output pins and bond wires of the AD8113.

From a circuit standpoint, this output crosstalk mechanism looks like a transformer with a mutual inductance between the windings that drives a load resistor. For low frequencies, the magnitude of the crosstalk is given by:

$$|XT| = 20 \log_{10} (M_{xy} \times s/R_L)$$

where M_{xy} is the mutual inductance of output X to output Y and R_L is the load resistance on the measured output. This crosstalk mechanism can be minimized by keeping the mutual inductance low and increasing R_L . The mutual inductance can be kept low by increasing the spacing of the conductors and minimizing their parallel length.

PCB Layout

Extreme care must be exercised to minimize additional crosstalk generated by the system circuit board(s). The areas that must be carefully detailed are grounding, shielding, signal routing, and supply bypassing.

The packaging of the AD8113 is designed to help keep the crosstalk to a minimum. Each input is separated from each other input by an analog ground pin. All of these AGNDs should be directly connected to the ground plane of the circuit board. These ground pins provide shielding, low impedance return paths and physical separation for the inputs. All of these help to reduce crosstalk.

Each output is separated from its two neighboring outputs by an analog supply pin of one polarity or the other. Each of these analog supply pins provides power to the output stages of only the two nearest outputs. These supply pins provide shielding, physical separation and a low impedance supply for the outputs. Individual bypassing of each of these supply pins with a 0.01 μF chip capacitor directly to the ground plane minimizes high frequency output crosstalk via the mechanism of sharing common impedances.

Each output also has an on-chip compensation capacitor that is individually tied to the nearby analog ground pins AGND00 through AGND07. This technique reduces crosstalk by preventing the currents that flow in these paths from sharing a common impedance on the IC and in the package pins. These AGNDxx signals should all be connected directly to the ground plane.

The input and output signals will have minimum crosstalk if they are located between ground planes on layers above and below, and separated by ground in between. Vias should be located as close to the IC as possible to carry the inputs and outputs to the inner layer. The input and output signals surface at the input termination resistors and the output series back-termination resistors. To the extent possible, these signals should also be separated as soon as they emerge from the IC package.

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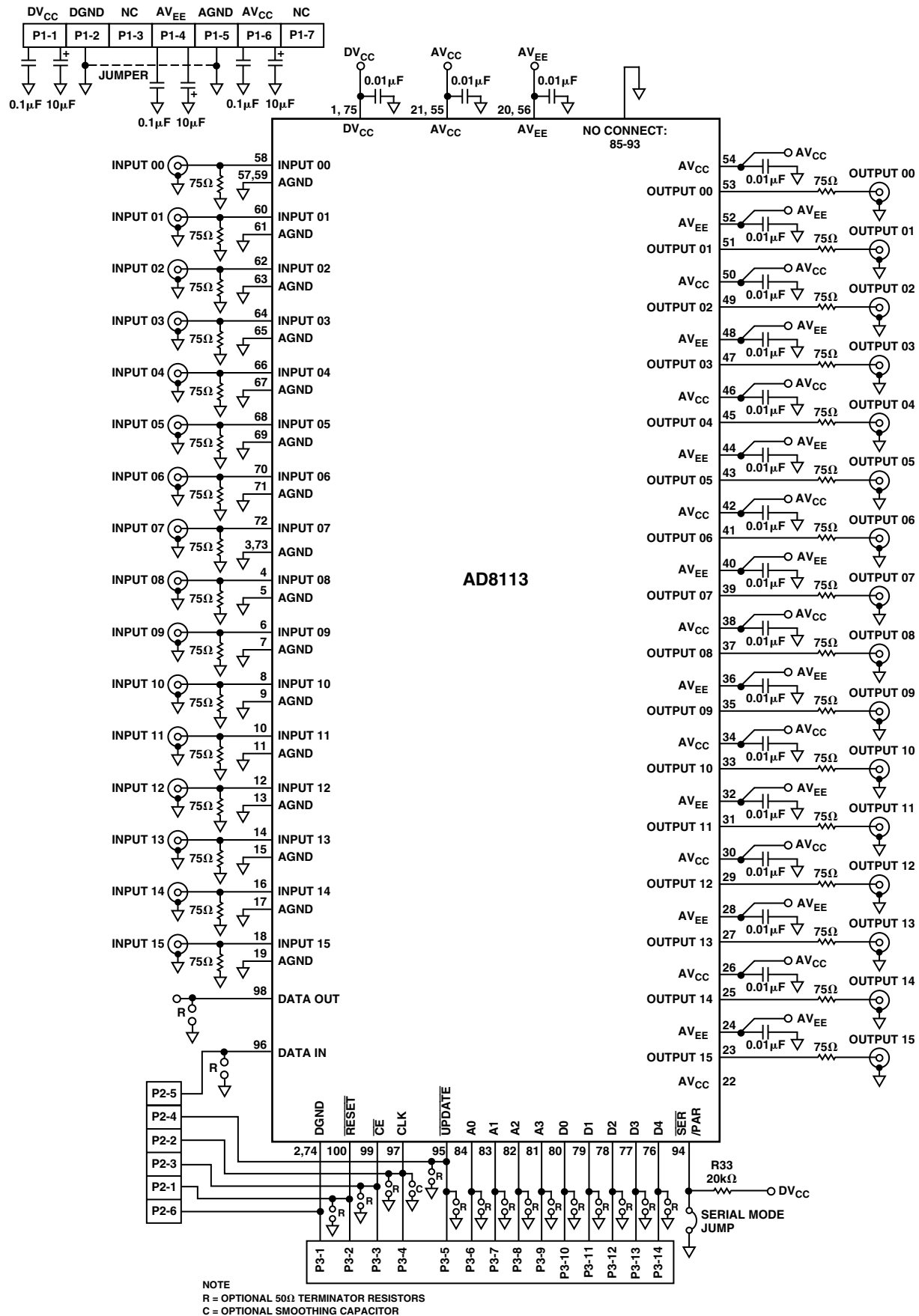


Figure 13. Evaluation Board Schematic

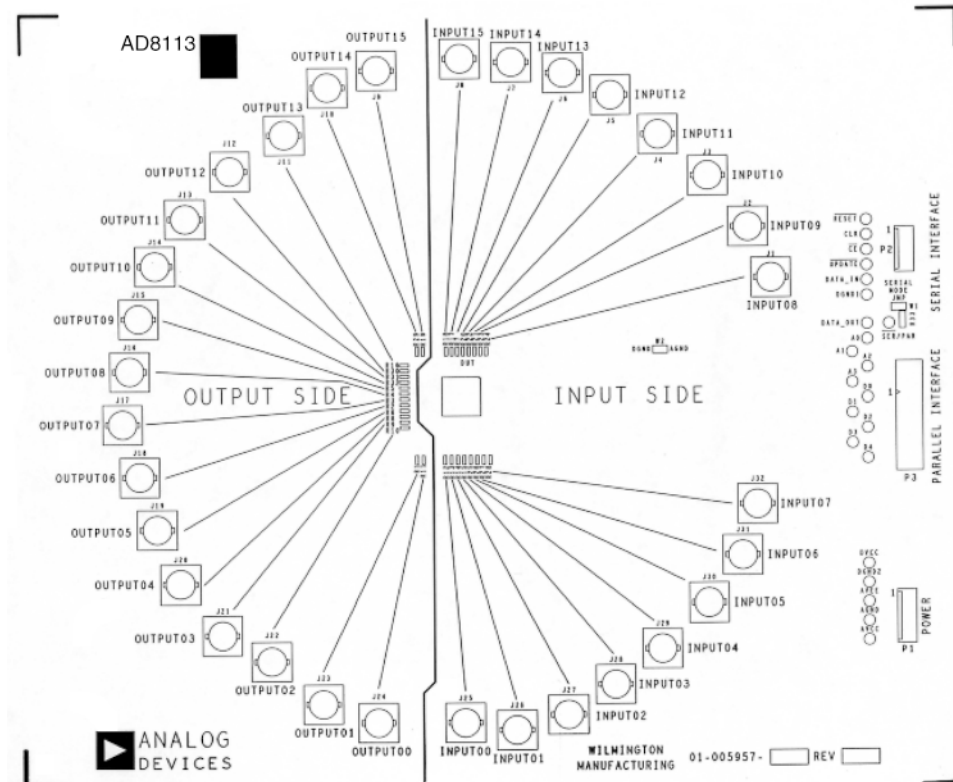


Figure 14. Component Side Silkscreen

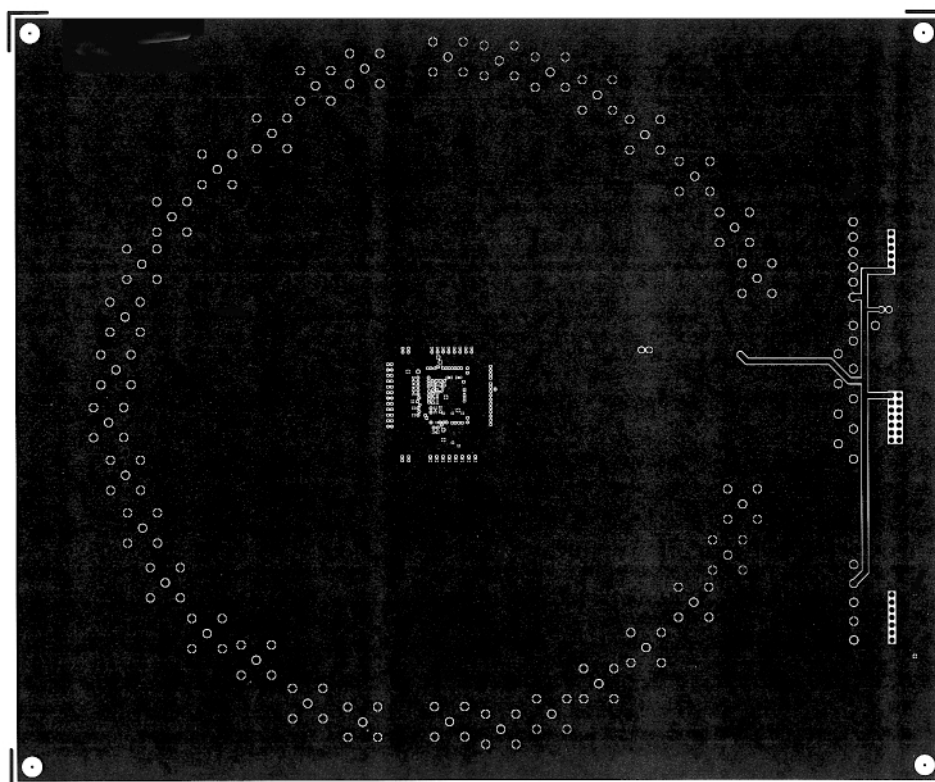


Figure 15. Board Layout (Ground Plane)

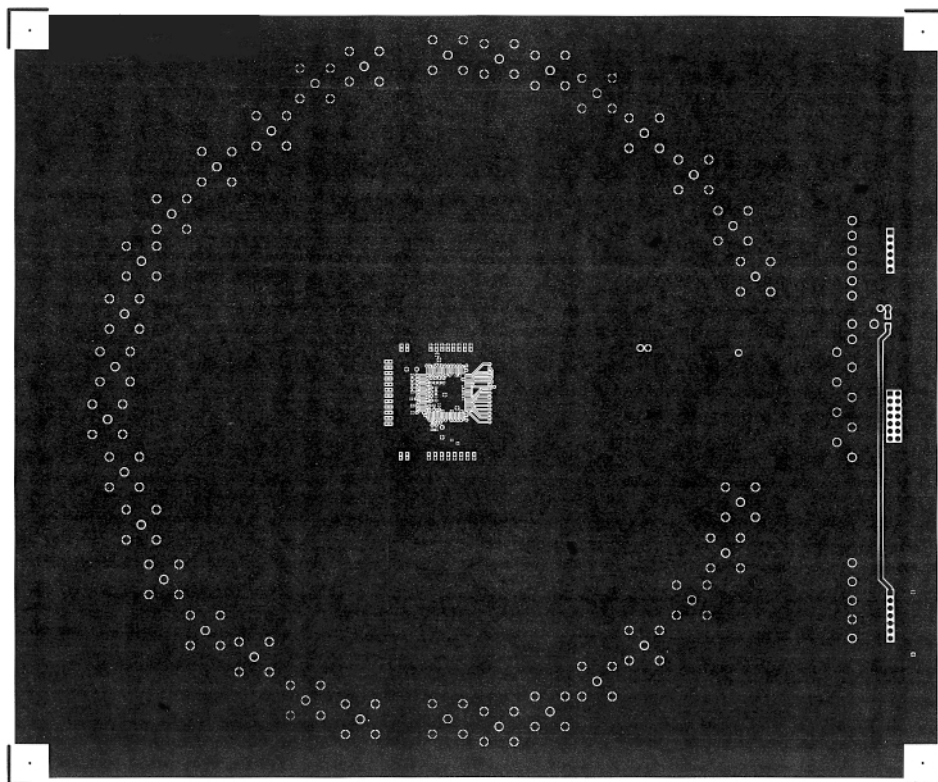


Figure 16. Board Layout (Component Side)

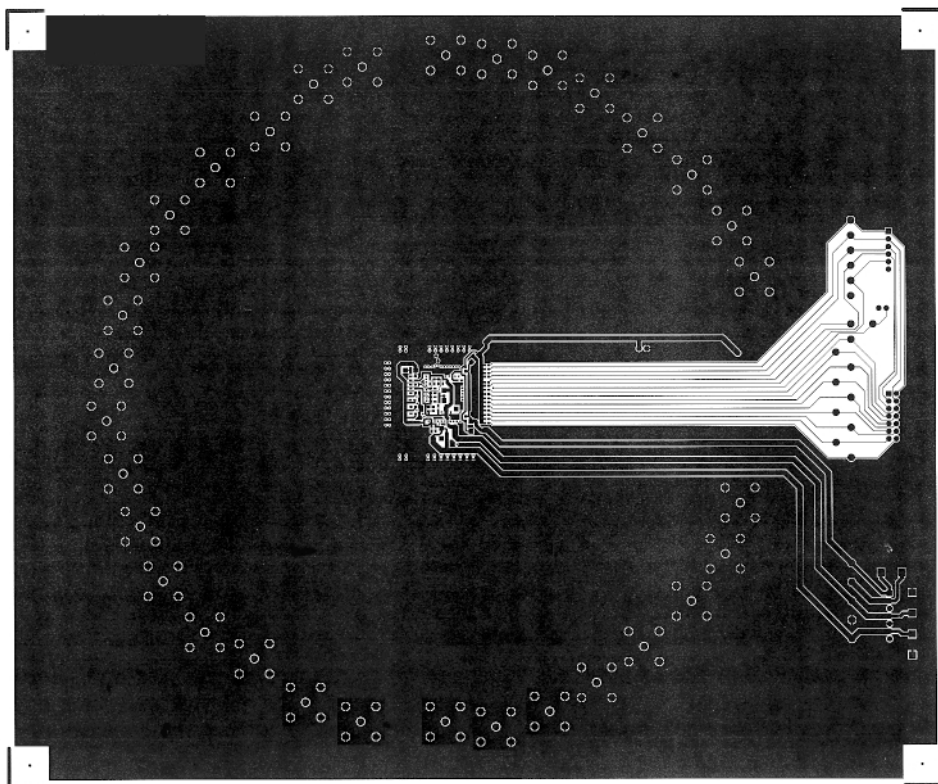


Figure 17. Board Layout (Circuit Side)

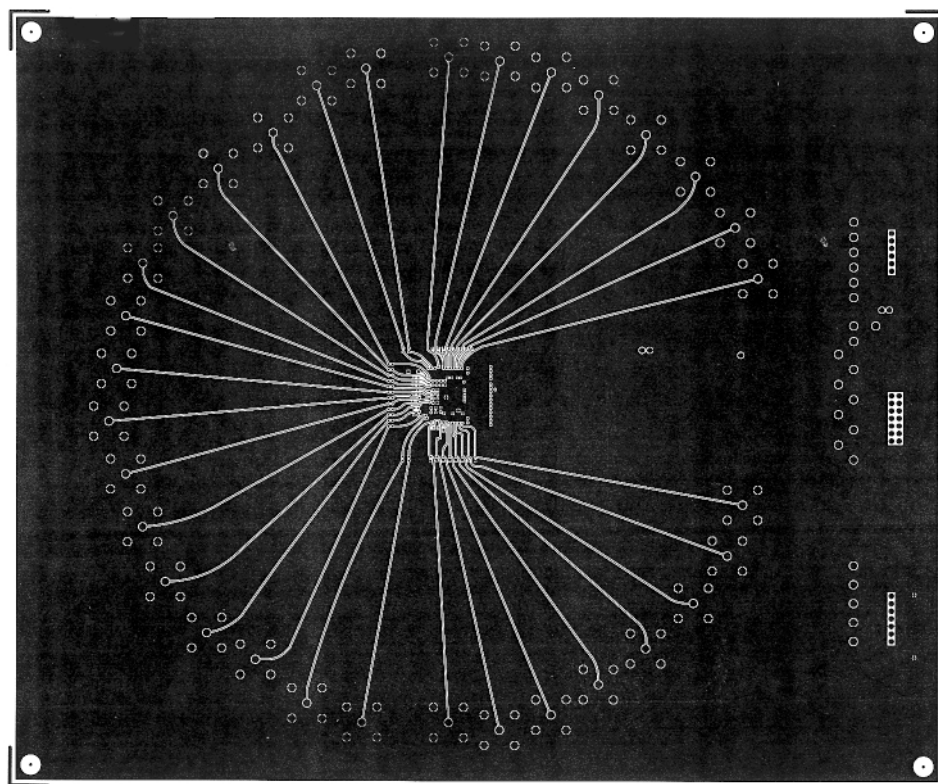


Figure 18. Board Layout (Signal Layer)

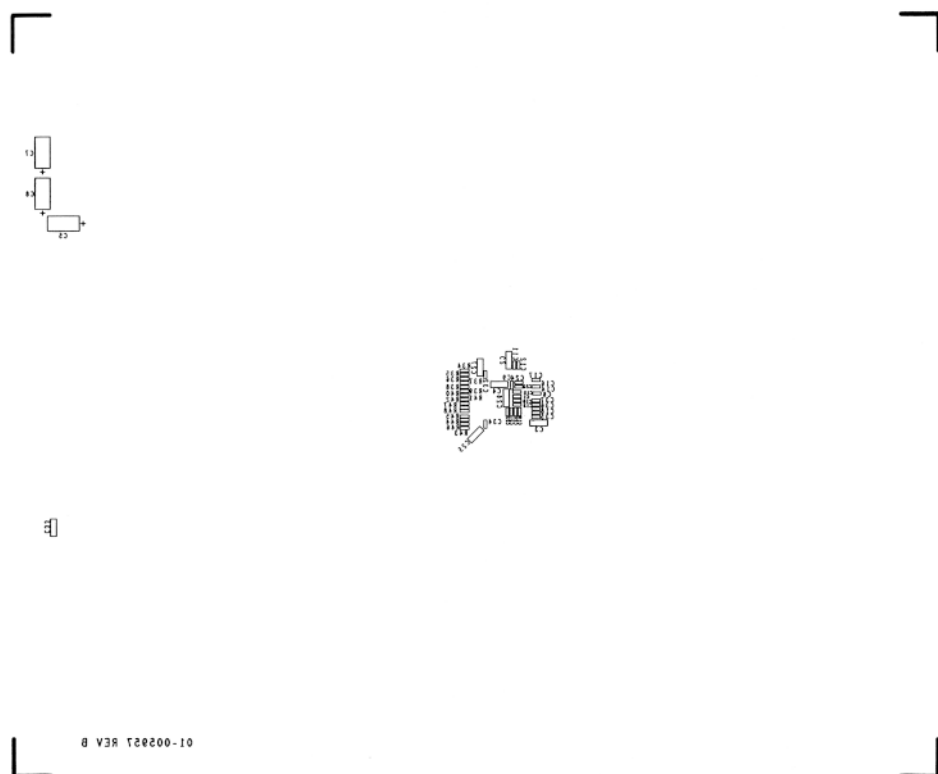


Figure 19. Circuit Side Silkscreen

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Optimized for video applications, all signal inputs and outputs are terminated with $75\ \Omega$ resistors. Stripline techniques are used to achieve a characteristic impedance on the signal input and output lines, also of $75\ \Omega$. Figure 20 shows a cross-section of one of the input or output tracks along with the arrangement of the PCB layers. It should be noted that unused regions of the four layers are filled up with ground planes. As a result, the input and output traces, in addition to having controlled impedances, are well shielded.

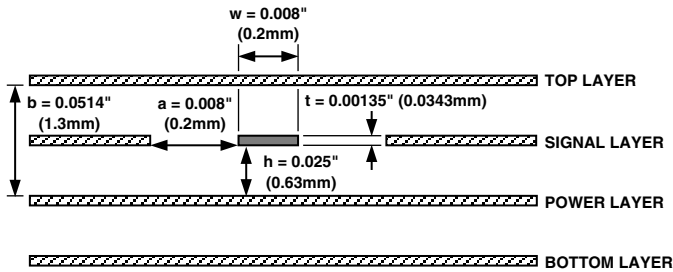


Figure 20. Cross-Section of Input and Output Traces

The board has 32 BNC type connectors: 16 inputs and 16 outputs. The connectors are arranged in a crescent around the device. As can be seen from Figure 16, this results in all 16 input signal traces and all 16 output traces having the same length. This is useful in tests such as All-Hostile Crosstalk where the phase relationship and delay between signals needs to be maintained from input to output.

There are separate digital (logic) and analog supplies. DV_{CC} should be at 5 V to be compatible with 5 V CMOS and TTL logic. AV_{CC} and AV_{EE} can range from ± 5 V to ± 12 V depending on the application.

As a general rule, each power supply pin (or group of adjacent power supply pins) should be locally decoupled with a $0.01\ \mu\text{F}$ capacitor. If there is a space constraint, it is more important to decouple analog power supply pins before digital power supply pins. A $0.1\ \mu\text{F}$ capacitor, located reasonably close to the pins, can be used to decouple a number of power supply pins. Finally a $10\ \mu\text{F}$ capacitor should be used to decouple power supplies as they come onto the board.

Controlling the Evaluation Board from a PC

The evaluation board includes Windows®-based control software and a custom cable that connects the board's digital interface to the printer port of the PC. The wiring of this cable is shown in Figure 21. The software requires Windows 3.1 or later to operate. To install the software, insert the disk labeled "Disk #1 of 2" in the PC and run the file called SETUP.EXE. Additional installation instructions will be given on-screen. Before beginning installation, it is important to terminate any other Windows applications that are running.

Audio signals are not as demanding on termination as are video signals. Therefore, the input terminations can be removed and changed. Likewise, the output series terminations can be shorted or changed in value.

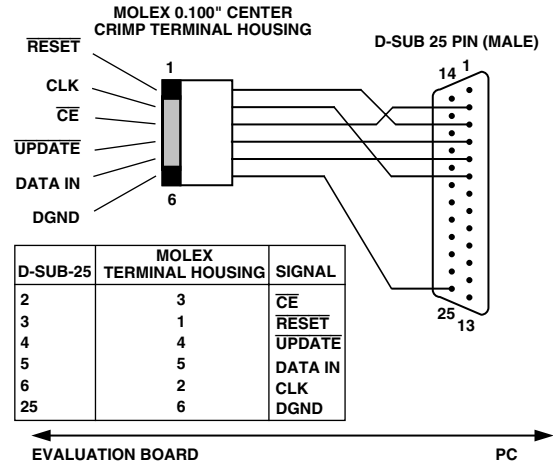


Figure 21. Evaluation Board/PC Connection Cable

When you launch the crosspoint control software, you will be asked to select the printer port you are using. Most modern PCs have only one printer port, usually called LPT1. However, some laptop computers use the PRN port.

Figure 22 shows the main screen of the control software in its initial reset state (all outputs off). Using the mouse, any input can be connected with one or more outputs by simply clicking on the appropriate radio buttons in the 16×16 on-screen array. Each time a button is clicked on, the software automatically sends and latches the required 80-bit data stream to the evaluation board. An output can be turned off by clicking the appropriate button in the Off column. To turn off all outputs, click on RESET.

While the computer software only supports serial programming via a PC's parallel port and the provided cable, the evaluation board has a connector that can be used for parallel programming. The $\overline{\text{SER/PAR}}$ signal should be at a logic high to use parallel programming. There is no cable nor software provided with the evaluation board for parallel programming. These are left to the user to provide.

The software offers volatile and nonvolatile storage of configurations. For volatile storage, up to two configurations can be stored and recalled using the Memory 1 and Memory 2 Buffers. These function in a fashion identical to the memory on a pocket calculator. For nonvolatile storage of a configuration, the Save Setup and Load Setup functions can be used. This stores the configuration as a data file on disk.

Overshoot on PC Printer Ports' Data Lines

The data lines on some printer ports have excessive overshoot. Overshoot on the pin that is used as the serial clock (Pin 6 on the D-Sub-25 connector) can cause communication problems. This overshoot can be eliminated by connecting a capacitor from the CLK line on the evaluation board to ground. A pad has been provided on the circuit-side (C33) of the evaluation board to allow this capacitor to be soldered into place. Depending upon the overshoot from the printer port, this capacitor may need to be as large as $0.01\ \mu\text{F}$.

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Parallel Port Selection

ANALOG DEVICES **16 X 16 Video Crosspoint Switch Evaluation Board Controller Rev.2**

Input Channel																Off	
0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15		
<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out0
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<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out2
<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out3
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<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out5
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<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out8
<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out9
<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out10
<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out11
<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out12
<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out13
<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out14
<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input type="radio"/>	<input checked="" type="radio"/>	Out15

Memory 1

X->M1

RM1

Memory 2

X->M2

RM2

Save Setup

Load Setup

Reset

OUTLINE DIMENSIONS

Dimensions shown in millimeters.

100-Lead Plastic Thin Quad Flatpack (LQFP)
(ST-100)

